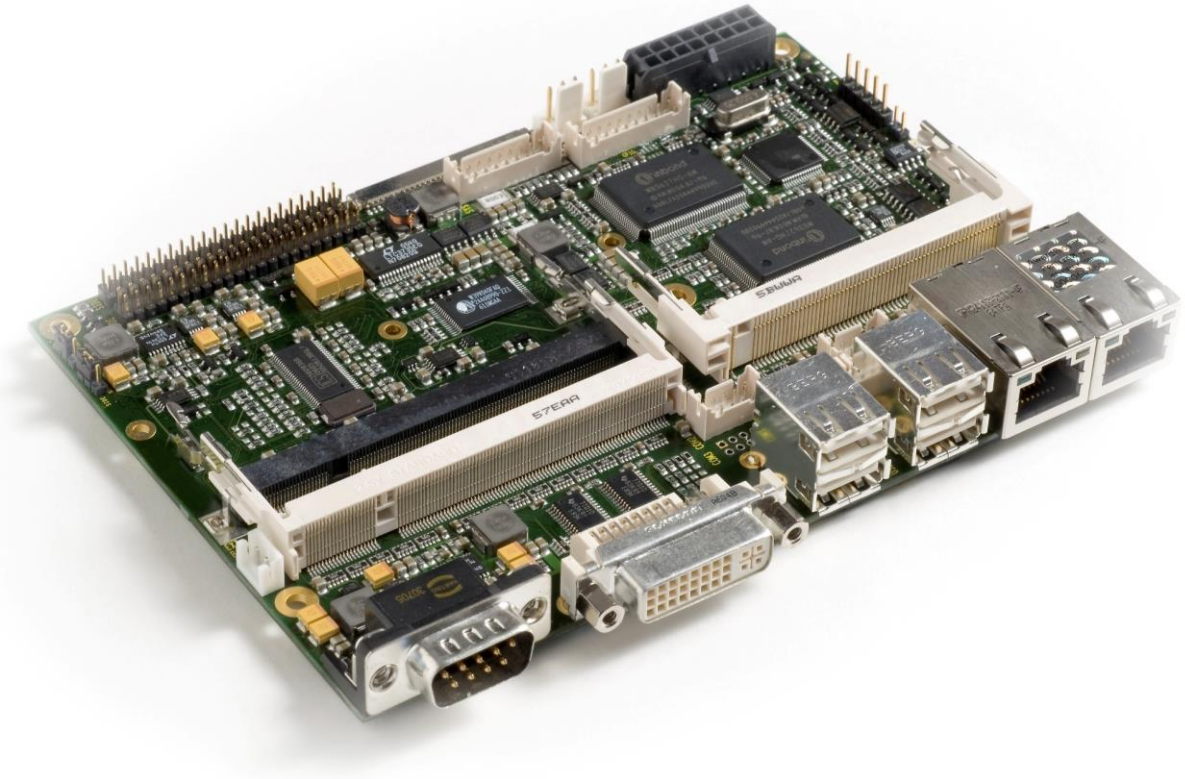
BECKHOFF

CB3050

Manual

rev. 1.5



Beckhoff Automation GmbH
Eiserstr. 5
33415 Verl
Germany

phone: +49 (0) 52 46/963-0
fax: +49 (0) 52 46/963-198
email: info@beckhoff.de
web: www.beckhoff.de

Contents

0 Document History

Version	Changes
0.1	first pre-release
0.2	updated resources section, updated block diagram, several minor changes
1.0	updated PCI table in annex, several minor changes
1.1	updated contact details, minor changes
1.2	image labels now language independent
1.3	added connector map, updated COM4 description, minor changes
1.4	minor changes
1.5	corrected LAN pinout

NOTE

1 Introduction

1.1 Notes on the Documentation

This description is only intended for the use of trained specialists in control and automation engineering who are familiar with the applicable national standards. It is essential that the following notes and explanations are followed when installing and commissioning these components.

1.1.1 Liability Conditions

The responsible staff must ensure that the application or use of the products described satisfy all the requirements for safety, including all the relevant laws, regulations, guidelines and standards.
The documentation has been prepared with care. The products described are, however, constantly under development. For that reason the documentation is not in every case checked for consistency with performance data, standards or other characteristics. None of the statements of this manual represents a guarantee (Garantie) in the meaning of § 443 BGB of the German Civil Code or a statement about the contractually expected fitness for a particular purpose in the meaning of § 434 par. 1 sentence 1 BGB. In the event that it contains technical or editorial errors, we retain the right to make alterations at any time and without warning. No claims for the modification of products that have already been supplied may be made on the basis of the data, diagrams and descriptions in this documentation.

1.1.2 Copyright

1.2 Safety Instructions

Please consider the following safety instructions and descriptions. Product specific safety instructions are to be found on the following pages or in the areas mounting, wiring, commissioning etc.

1.2.1 Disclaimer

All the components are supplied in particular hardware and software configurations appropriate for the application. Modifications to hardware or software configurations other than those described in the documentation are not permitted, and nullify the liability of Beckhoff Automation GmbH.

1.2.2 Description of Safety Symbols

The following safety symbols are used in this documentation. They are intended to alert the reader to the associated safety instructions.

ACUTE RISK OF INJURY!

If you do not adhere to the safety advise next to this symbol, there is immediate danger to life and health of individuals!

RISK OF INJURY!

If you do not adhere to the safety advise next to this symbol, there is danger to life and health of individuals!

HAZARD TO INDIVIDUALS, ENVIRONMENT, DEVICES, OR DATA!

If you do not adhere to the safety advise next to this symbol, there is obvious hazard to individuals, to environment, to materials, or to data.

NOTE OR POINTER

This symbol indicates information that contributes to better understanding.

1.3 Essential Safety Measures

1.3.1 Operator's Obligation to Exercise Diligence

The operator must ensure that

- the product is only used for its intended purpose
- the product is only operated in sound condition and in working order
- the instruction manual is in good condition and complete, and always available for reference at the location where the products are used
- the product is only used by suitably qualified and authorised personnel
- the personnel is instructed regularly about relevant occupational safety and environmental protection aspects
- the operating personnel is familiar with the operating manual and in particular the safety notes contained herein

1.3.2 National Regulations Depending on the Machine Type

Depending on the type of machine and plant in which the product is used, national regulations governing the controllers of such machines will apply, and must be observed by the operator. These regulations cover, amongst other things, the intervals between inspections of the controller. The operator must initiate such inspections in good time.

1.3.3 Operator Requirements

- Read the operating instructions

All users of the product must have read the operating instructions for the system they work with.

- System know-how

All users must be familiar with all accessible functions of the product.

1.4 Functional Range

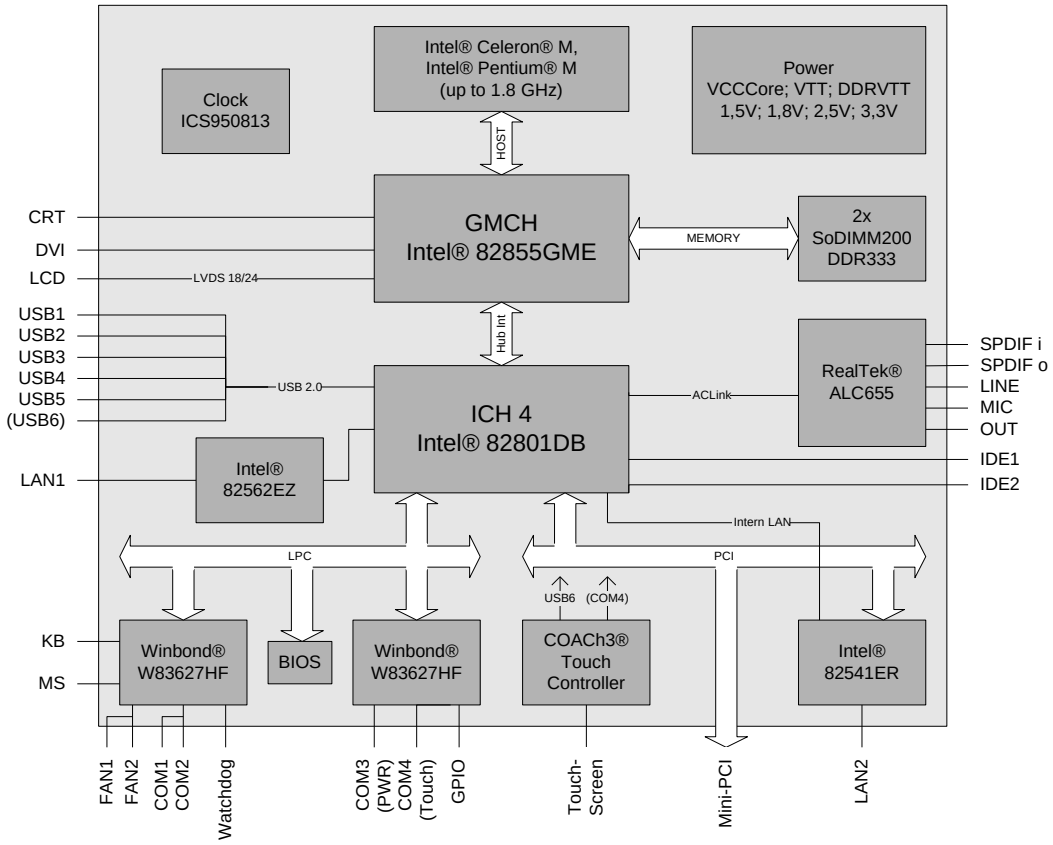
NOTE

The descriptions contained in the present documentation represent a detailed and extensive product description. As far as the described motherboard was acquired as an integral component of an Industrial PC from Beckhoff Automation GmbH, this product description shall be applied only in limited scope. Only the contractually agreed specifications of the corresponding Industrial PC from Beckhoff Automation GmbH shall be relevant. Due to several models of Industrial PCs, variations in the component placement of the motherboards are possible. Support and service benefits for the built-in motherboard will be rendered by Beckhoff Automation GmbH exclusively as specified in the product description (inclusive operation system) of the particular Industrial PC.

2 Overview

2.1 Features

The CB3050 is a highly complex 3,5-inch board with the functionalities of a motherboard. It is equipped with either an Intel® Celeron® M or an Intel® Pentium® M CPU, with up to 2 GByte DDR-RAM via SO-DIMM200, with a Mini-PCI-bus and with additional periphery such as four serial busses, two LAN-connectors, sound input and output, six USB channels, CRT and TFT connectors and two IDE channels. Furthermore, a touch screen can be connected to the board.



- Processor Intel® Celeron® M, Intel® Celeron® M ULV, or Intel® Pentium® M up to 1,8GHz
- Chipset Intel® 855GME and Intel ICH4
- DDR-RAM via 2 x SO-DIMM200 up to 2 GByte DDR-333 with ECC
- Four serial interfaces COM1 up to COM4
- 1x Ethernet 10/100 (BaseT), 1x Ethernet 10/100/1000 (BaseT).
- Two IDE interfaces
- PS/2 keyboard / mouse interface
- Six USB 2.0 interfaces
- AWARD® BIOS 6.10
- CRT connection
- DVI connection
- TFT connection, LVDS 18/24 bit (single and dual pixel displays)
- AC97 compatible sound controller with SPDIF in and out
- RTC with external CMOS battery
- 5V single supply voltage
- Mini-PCI Interface

- Touch screen interface
- Size 102 mm x 147 mm

2.2 Specifications and Documents

In making this manual and for further reading of technical documentation, the following documents, specifications and web-pages were used and are recommended.

- PCI specification
  version 2.3 and 3.0
  www.pcisig.com
- Mini-PCI specification
  version 1.0
  www.pcisig.com
- ACPI specification
  version 3.0
  www.acpi.info
- ATA/ATAPI specification
  version 7 rev. 1
  www.t13.org
- USB specifications
  www.usb.org
- SM-Bus specification
  version 2.0
  www.smbus.org
- Intel chip description
  855GM/GME datasheet, design guide
  www.intel.com
- Intel chip description
  ICH4 datasheet
  www.intel.com
- Winbond chip description
  W83627HF datasheet
  www.winbond-usa.com or www.winbond.com.tw
- Intel chip description
  82541ER datasheet
  www.intel.com
- Intel chip description
  82551ER datasheet
  www.intel.com
- Intel chip description
  82562EZ datasheet
  www.intel.com
- ICS chip description
  ICS950813 datasheet
  www.icst.com
- Chrontel chip description
  Chrontel 7301C
  www.chrontel.com
- Elo TouchSystems chip description
  COACh3
  www.elotouch.de
  (NDA required)

3 Detailed Description

3.1 Power Supply

The power supply of the hardware module is effected via the power connector. The board requires an operating voltage of 5 volt ± 5%. The two fan connectors can be attached to 12 volt if required.

3.2 CPU

The board can be ordered with one of the following processors employed: Intel® Celeron® M, Intel® Celeron® M ULV, Intel® Pentium® M. The package type allows a maximum DIE temperature of 100 degrees Celsius and accords highest possible security even in rough environment.
The processors include a second level cache of up to 2 MByte, depending on which model is used. Furthermore the processors offer many features known from the desktop range such as MMX2, serial number, loadable microcode etc.

3.3 Memory

There is one conventional SO-DIMM200 socket available to equip the board with memory. For technical and mechanical reasons it is possible that particular memory modules cannot be employed. Please ask your sales representative for recommended memory modules.
With currently available SO-DIMM200 modules a memory extension up to 2 GByte is possible (DDR-333).

NOTE

For higher security demands SO-DIMM200 modules with ECC parity checking are available. The BIOS will use this option automatically, though it can be manually disabled in setup. You may notice a performance decrease with ECC enabled, when using higher video resolutions.

4 Connectors

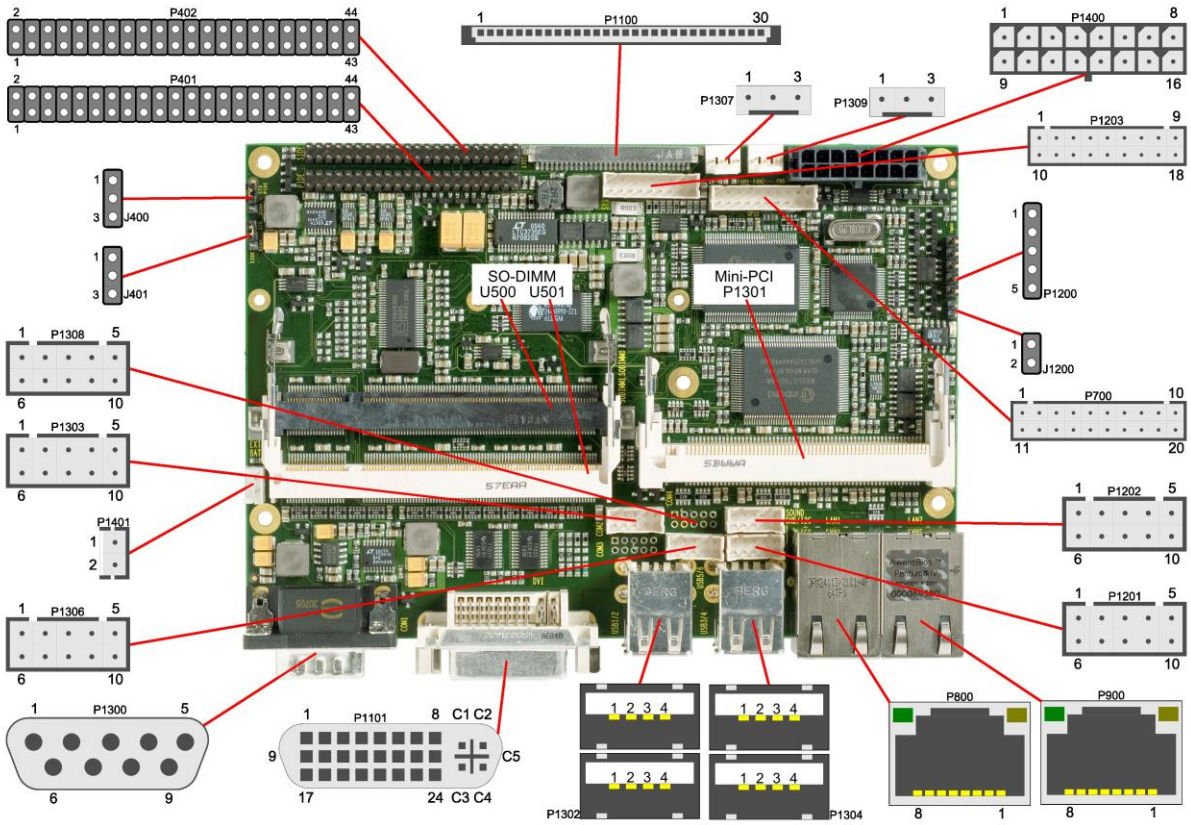
This section describes all the connectors found on the CB3050.

CAUTION

For most interfaces, the cables must meet certain requirements. For instance, USB 2.0 requires twisted and shielded cables to reliably maintain full speed data rates. Restrictions on maximum cable length are also in place for many high speed interfaces and for power supply. Please refer to the respective specifications and use suitable cables at all times.

4.1 Connector Map

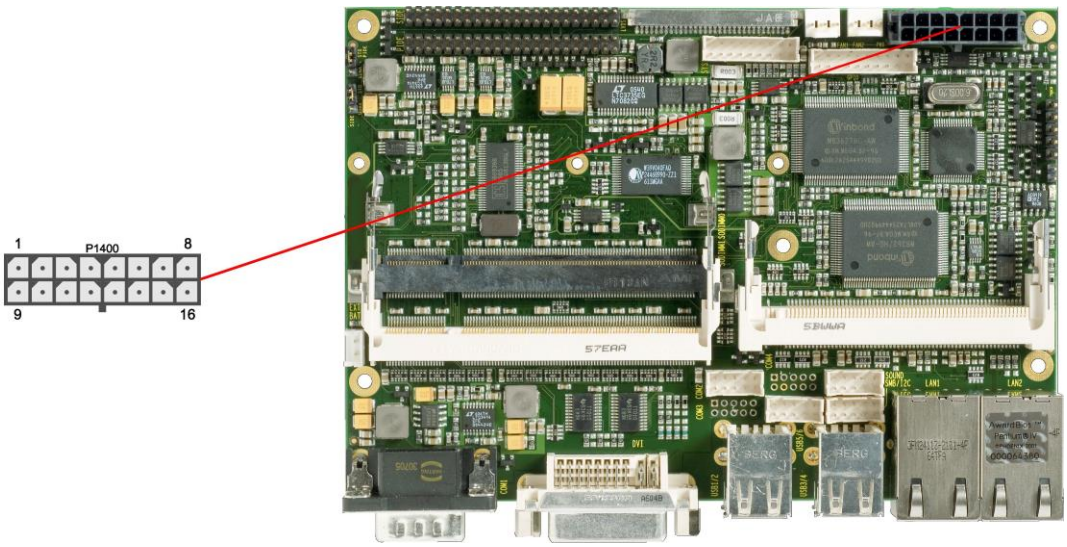
Please use the connector map below for quick reference. Only connectors on the component side are shown. For more information on each connector refer to the table below.



Ref-No.	Function	Page
J400/1	"IDE Interfaces"	p. 32
P401/2	"IDE Interfaces"	p. 32
U500/1	"Memory"	p. 21
P700	"GPIO"	p. 39
P800	"LAN1"	p. 29
P900	"LAN2"	p. 30
P1100	"LVDS"	p. 25
P1101	"VGA/DVI"	p. 24
P1200/J1200	"Touch Screen"	p. 27
P1201	"SMB/I2C"	p. 36
P1202	"Audio"	p. 31
P1203	"System"	p. 19
P1300	"Serial Interface COM1"	p. 34
P1301	"Mini-PCI"	p. 37
P1302/4	"USB"	p. 28
P1303/8	"Serial Ports COM2 through COM4"	p. 35
P1306	"USB"	p. 28
P1307/9	"Fan Connectors"	p. 40
P1401	"External CMOS Battery"	p. 20
P1400	"Power Supply"	p. 18

4.2 Power Supply

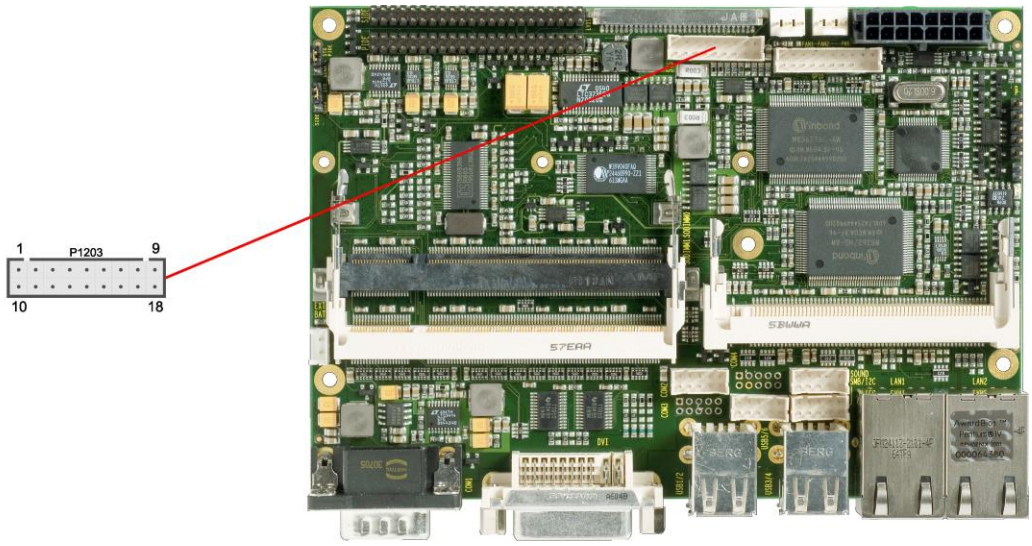
The power supply of the hardware module is realized via a 2x8-pin connector (Molex PS 43045-16xx, mating connector: Molex PS 43025-16xx). The pins for 12 volt have the sole purpose of supplying one or both fans with the necessary current. Thus, when no fan is installed, these pins have no function. COM3 RXD and TXD can also be used for connecting a second power supply unit, e. g. for UPS. As an ordering option SMBus signals SCL/SDA can be provided (replacing COM3 TXD/RXD).



Description	Name	Pin		Name	Description
COM3 transmit data	TXD	1	9	RXD	COM3 receive data
PSU on	PS-ON	2	10	PWRGD	Powergood
powerbutton PSU	PWRBTN#	3	11	SVCC	standby-supply 5V
12 volt supply	12V	4	12	12V	12 volt supply
ground	GND	5	13	GND	ground
ground	GND	6	14	GND	ground
5 volt supply	VCC	7	15	VCC	5 volt supply
5 volt supply	VCC	8	16	VCC	5 volt supply

4.3 System

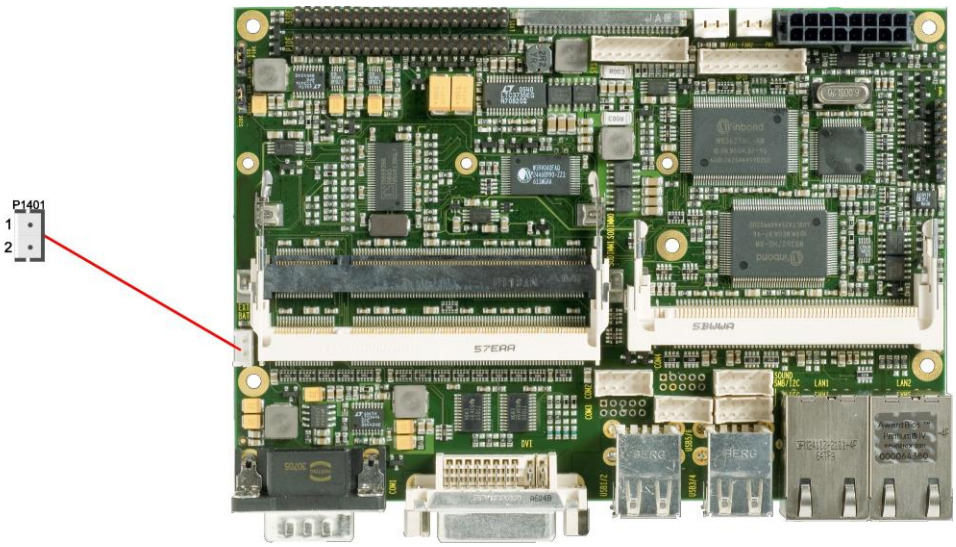
Some typical signals for system control are provided through a 2x9 pin connector (JST B18B-PHDSS, mating connector: PHDR-18VS). This connector combines signals for power button, reset, keyboard, speaker, and several LEDs such as harddisk LED, touch screen LED, suspend LED, and three additional LEDs which are driven by GPIOs. Of these three GPIO-LEDs, LED1 and LED2 are already provided with a series resistor. As can be seen from the pinout table below, corresponding signals are often placed vis-à-vis or at least near to each other.



Description	Name	Pin		Name	Description
ground	GND	1	10	PWRBTN#	on/suspend button
ground	GND	2	11	RESET#	reset to ground
LED touch screen	TOUCHLED	3	12	3.3V	3.3 volt supply
LED suspend / ACPI	S-LED	4	13	S3.3V	standby supply 3.3 volt
LED harddisk	HDLED	5	14	3.3V	3.3 volt supply
LED GPIO device	LED1	6	15	3.3V	3.3 volt supply
LED GPIO device	LED2	7	16	LED3	LED GPIO device
speaker to 5 volt	SPEAKER	8	17	KDAT	keyboard data
standby supply 5 volt	(S)VCC	9	18	KCLK	keyboard clock

4.4 External CMOS Battery

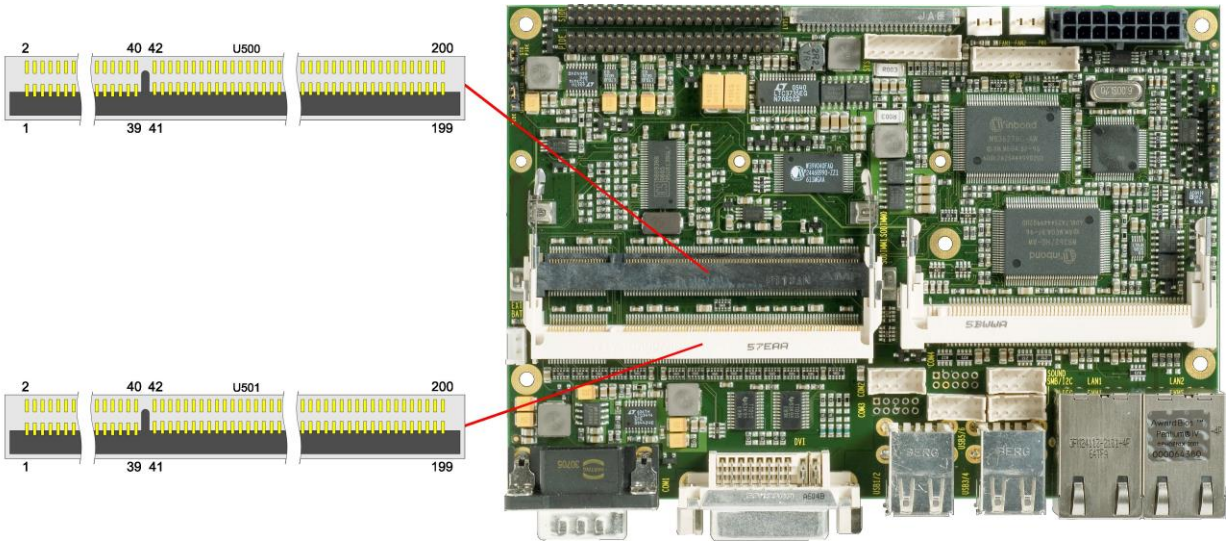
For keeping the internal clock alive even if the rest of the board is switched off, an external battery can be attached via a 2 pin connector (JST B2B-EH-A, mating connector: EHR-2).



Pin	Name	Description
1	BATT	battery 3.3 volt
2	GND	ground

4.5 Memory

Conventional SO-DIMM200 memory modules, as familiar from notebook computers, are used to equip the board with memory. For technical and mechanical reasons it is possible that particular memory modules cannot be employed. Please ask your distributor for recommended memory modules.
With currently available SO-DIMM200 modules a memory extension up to 2 GByte is possible (DDR-333).
All timing parameters for different memory modules are automatically set by BIOS.



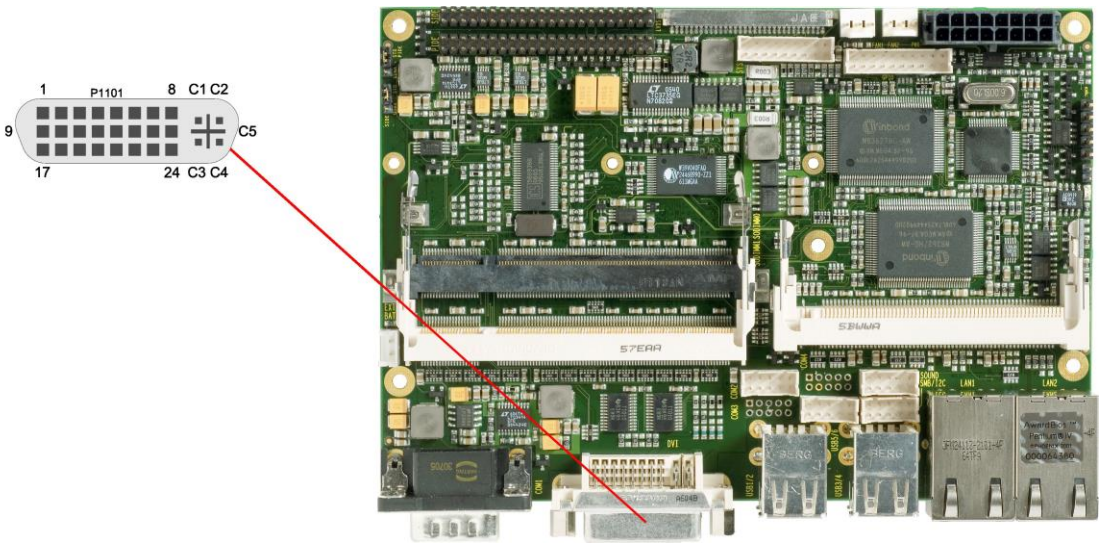
Description	Name	Pin		Name	Description
memory reference current	REF	1	2	REF	memory reference current
ground	GND	3	4	GND	ground
data 0	DQ0	5	6	DQ4	data 4
data 1	DQ1	7	8	DQ5	data 5
2.5 volt supply	2.5V	9	10	2.5V	2.5 volt supply
data strobe 0	DQS0	11	12	DQM0	data mask 0
data 2	DQ2	13	14	DQ6	data 6
ground	GND	15	16	GND	ground
data 3	DQ3	17	18	DQ7	data 7
data 8	DQ8	19	20	DQ12	data 12
2.5 volt supply	2.5V	21	22	2.5V	2.5 volt supply
data 9	DQ9	23	24	DQ13	data 13
data strobe 1	DQS1	25	26	DQM1	data mask 1
ground	GND	27	28	GND	ground
data 10	DQ10	29	30	DQ14	data 14
data 11	DQ11	31	32	DQ15	data 15
2.5 volt supply	2.5V	33	34	2.5V	2.5 volt supply
clock	CK0	35	36	2.5V	2.5 volt supply
clock	CK0#	37	38	2.5V	2.5 volt supply
ground	GND	39	40	GND	ground
data 16	DQ16	41	42	DQ20	data 20
data 17	DQ17	43	44	DQ21	data 21
2.5 volt supply	2.5V	45	46	2.5V	2.5 volt supply
data strobe 2	DQS2	47	48	DQM2	data mask 2
data 18	DQ18	49	50	DQ22	data 22
ground	GND	51	52	GND	ground

Description	Name	Pin		Name	Description
data 19	DQ19	53	54	DQ23	data 23
data 24	DQ24	55	56	DQ28	data 28
2.5 volt supply	2.5V	57	58	2.5V	2.5 volt supply
data 25	DQ25	59	60	DQ29	data 29
data strobe 3	DQS3	61	62	DQM3	data mask 3
ground	GND	63	64	GND	ground
data 26	DQ26	65	66	DQ30	data 30
data 27	DQ27	67	68	DQ31	data 31
2.5 volt supply	2.5V	69	70	2.5V	2.5 volt supply
data check bit 0	CB0	71	72	CB4	data check bit 4
data check bit 1	CB1	73	74	CB5	data check bit 5
ground	GND	75	76	GND	ground
data strobe 8	DQS8	77	78	DQM8	data mask 8
data check bit 2	CB2	79	80	CB6	data check bit 6
2.5 volt supply	2.5V	81	82	2.5V	2.5 volt supply
data check bit 3	CB3	83	84	CB7	data check bit 7
reserved	N/C	85	86	N/C	reserved
ground	GND	87	88	GND	ground
clock	CK2	89	90	GND	ground
clock	CK2#	91	92	2.5V	2.5 volt supply
2.5 volt supply	2.5V	93	94	2.5V	2.5 volt supply
clock enables 1	CKE1	95	96	CKE0	clock enables 0
reserved	N/C	97	98	N/C	reserved
address 12	A12	99	100	A11	address 11
address 9	A9	101	102	A8	address 8
ground	GND	103	104	GND	ground
address 7	A7	105	106	A6	address 6
address 5	A5	107	108	A4	address 4
address 3	A3	109	110	A2	address 2
address 1	A1	111	112	A0	address 0
2.5 volt supply	2.5V	113	114	2.5V	2.5 volt supply
address 10	A10	115	116	BA1	SDRAM bank 1
SDRAM bank 0	BA0	117	118	RAS#	row address strobe
write enable	WE#	119	120	CAS#	column address strobe
chip select	S0#	121	122	S1#	chip select
reserved	N/C	123	124	N/C	reserved
ground	GND	125	126	GND	ground
data 32	DQ32	127	128	DQ36	data 36
data 33	DQ33	129	130	DQ37	data 37
2.5 volt supply	2.5V	131	132	2.5V	2.5 volt supply
data strobe 4	DQS4	133	134	DQM4	data mask 4
data 34	DQ34	135	136	DQ38	data 38
ground	GND	137	138	GND	ground
data 35	DQ35	139	140	DQ39	data 39
data 40	DQ40	141	142	DQ44	data 44
2.5 volt supply	2.5V	143	144	2.5V	2.5 volt supply
data 41	DQ41	145	146	DQ45	data 45
data strobe 5	DQS5	147	148	DQM5	data mask 5
ground	GND	149	150	GND	ground
data 42	DQ42	151	152	DQ46	data 46
data 43	DQ43	153	154	DQ47	data 47
2.5 volt supply	2.5V	155	156	2.5V	2.5 volt supply
2.5 volt supply	2.5V	157	158	CK1#	clock
ground	GND	159	160	CK1	clock
ground	GND	161	162	GND	ground

Description	Name	Pin		Name	Description
data 48	DQ48	163	164	DQ52	data 52
data 49	DQ49	165	166	DQ53	data 53
2.5 volt supply	2.5V	167	168	2.5V	2.5 volt supply
data strobe 6	DQS6	169	170	DQM6	data mask 6
data 50	DQ50	171	172	DQ54	data 54
ground	GND	173	174	GND	ground
data 51	DQ51	175	176	DQ55	data 55
data 56	DQ56	177	178	DQ60	data 60
2.5 volt supply	2.5V	179	180	2.5V	2.5 volt supply
data 57	DQ57	181	182	DQ61	data 61
data strobe 7	DQS7	183	184	DQM7	data mask 7
ground	GND	185	186	GND	ground
data 58	DQ58	187	188	DQ62	data 62
data 59	DQ59	189	190	DQ63	data 63
2.5 volt supply	2.5V	191	192	2.5V	2.5 volt supply
SPD data	SDA	193	194	SA0	SPD address
SPD clock	SCL	195	196	SA1	SPD address
3.3 volt supply	3.3V	197	198	SA2	SPD address
reserved	N/C	199	200	N/C	reserved

4.6 VGA/DVI

The module is equipped with a standard DVI-I-connector, which can be used to connect either a DVI capable display or a standard VGA CRT – using a DVI-DSUB adapter, if necessary.

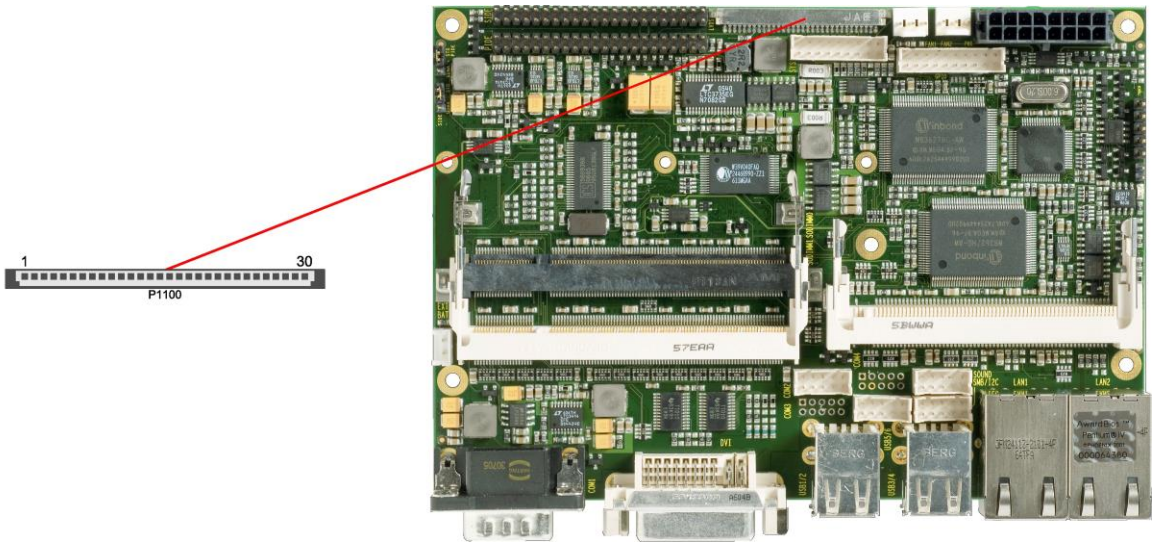


Pinout DVI-I:

Pin	Name	Description
1	TMDSDAT2#	DVI data 2 -
2	TMDSDAT2	DVI data 2 +
3	GND	ground
4	N/C	reserved
5	N/C	reserved
6	DDC CLK	DDC clock (DVI/VGA)
7	DDC DAT	DDC data (DVI/VGA)
8	VSYNC	VGA vertical sync
9	TMDSDAT1#	DVI data 1 -
10	TMDSDAT1	DVI data 1 +
11	GND	ground
12	N/C	reserved
13	N/C	reserved
14	VCC	5 volt supply
15	GND	ground
16	HP_DETECT	hot plug detect
17	TMDSDAT0#	DVI data 0 -
18	TMDSDAT0	DVI data 0 +
19	GND	ground
20	N/C	reserved
21	N/C	reserved
22	GND	ground
23	TMDS CLK	DVI clock
24	TMDS CLK#	DVI clock
C1	RED	VGA red
C2	GREEN	VGA green
C3	BLUE	VGA blue
C4	HSYNC	VGA horizontal sync
C5	GND	ground

4.7 LVDS

The board also offers the possibility to use displays with LVDS interface. These can be connected via a 30 pin flat-cable plug (JAE FI-X30S-HF-NPB, mating connector: FI-X30C(2)-NPB). Only shielded and twisted cables may be used. The display type is to be chosen over the BIOS setup. The connector has two additional shield pins S1 and S2 which are omitted in the pinout table below.



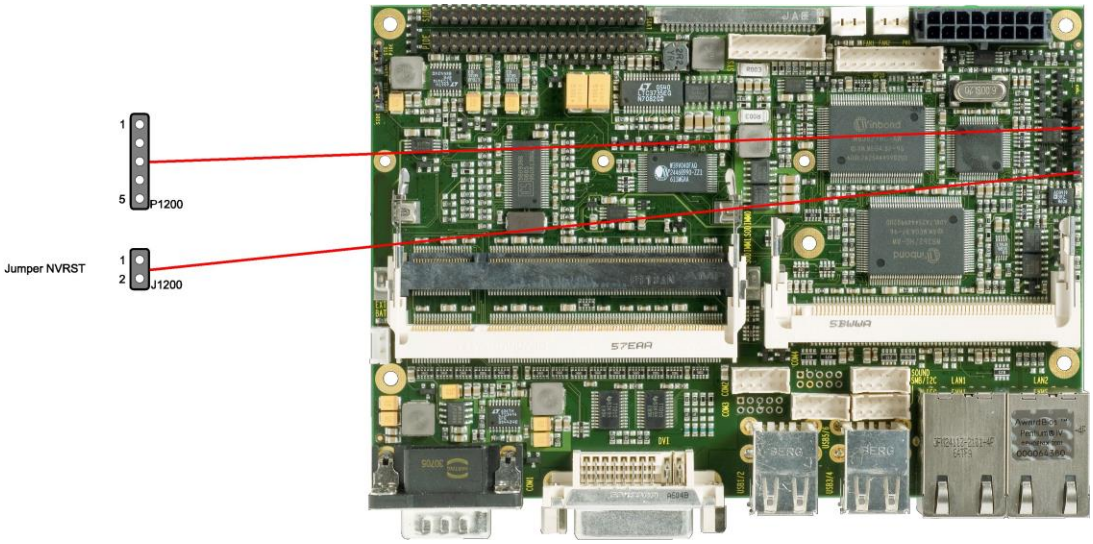
Pinout LVDS connector:

Pin	Name	Description
1	TXO00#	LVDS even data 0 -
2	TXO00	LVDS even data 0 +
3	TXO01#	LVDS even data 1 -
4	TXO01	LVDS even data 1 +
5	TXO02#	LVDS even data 2 -
6	TXO02	LVDS even data 2 +
7	GND	ground
8	TXO0C#	LVDS even clock -
9	TXO0C	LVDS even clock +
10	TXO03#	LVDS even data 3 -
11	TXO03	LVDS even data 3 +
12	TXO10#	LVDS odd data 0 -
13	TXO10	LVDS odd data 0 +
14	GND	ground
15	TXO11#	LVDS odd data 1 -
16	TXO11	LVDS odd data 1 +
17	GND	ground
18	TXO12#	LVDS odd data 2 -
19	TXO12	LVDS odd data 2 +
20	TXO1C#	LVDS odd clock -
21	TXO1C	LVDS odd clock +
22	TXO13#	LVDS odd data 3 -
23	TXO13	LVDS odd data 3 +
24	GND	ground
25	3.3V	3.3 volt supply
26	DDC_CLK	EDID clock for LCD

Pin	Name	Description
27	DDC_DAT	EDID data for LCD
28	FP_3.3V	switched 3.3 volt for display
29	FP_BL	switched 5 volt for backlight
30	VCC	5 volt supply

4.8 Touch Screen

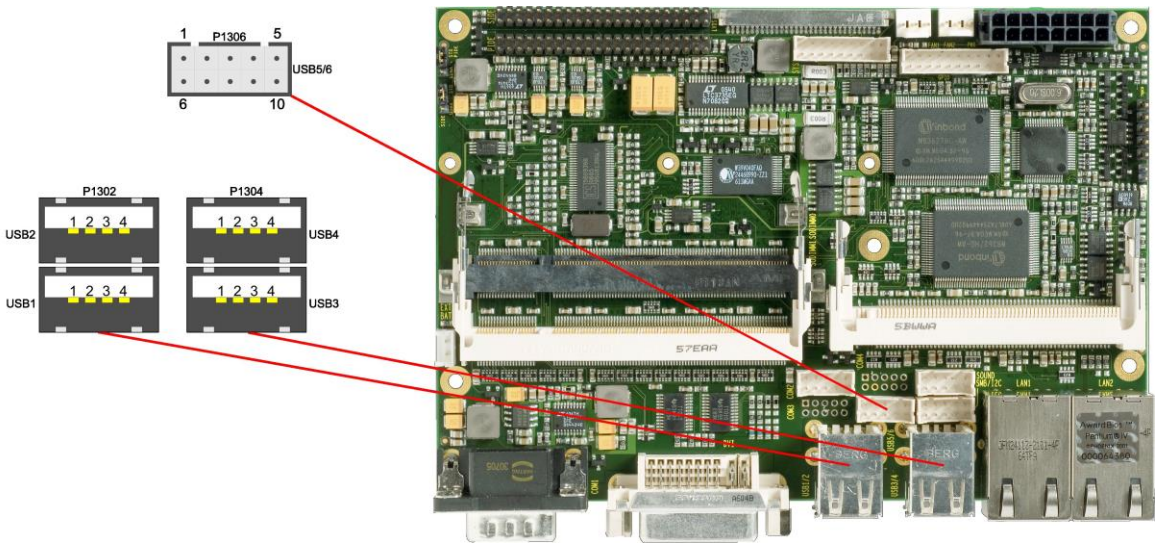
A key feature of the CB3050 is the possibility to connect a touch screen. Both 4-wire and 5-wire resistive touch screens are supported. For receiving the relevant signals a 5 pin standard IDC socket connector with a spacing of 2.54 mm is provided. If the connected touch screen is 4-wire then pin 1 will not be used. There is an accompanying jumper which, if shorted at boot time, triggers the NVRST-signal in the controller, thereby resetting all parameters of NVRAM to default values.
Conversion to the respective connector of the touch screen must be provided externally. Please consult the manufacturer's documentation to figure out the relevant technical details.
Note: In the pinout table below H, X, S, Y, and L are the signal names in the case of 5-wire, XL, XR, YT, and YB are the names in the case of 4-wire.



Pin	Name	Description
1	H-DRV	H driver control
2	X/XL-DRV	X/XL driver control
3	S/XR-DRV	S/XR driver control
4	Y/YT-DRV	Y/YT driver control
5	L/YB-DRV	L/YB driver control

4.9 USB

The hardware module has six USB channels four of which (USB1 to USB4) are available as standard USB connectors. The other two channels are provided as a 2x5 pin connector (JST B10B-PHDSSLFSN, mating connector: PHDR-10VS).
All USB-channels support USB 2.0. You may note that the setting of USB keyboard or USB mouse support in the BIOS-setup is only necessary and advisable, if the OS offers no USB-support. BIOS-setup can be changed with an USB keyboard without enabling USB keyboard support. Running Windows with these features enabled may lead to significant performance or functionality limitations.
Every USB interface provides up to 500 mA current and is protected by an electronical fuse.



Pinout 2x5 pin connector USB 5/6

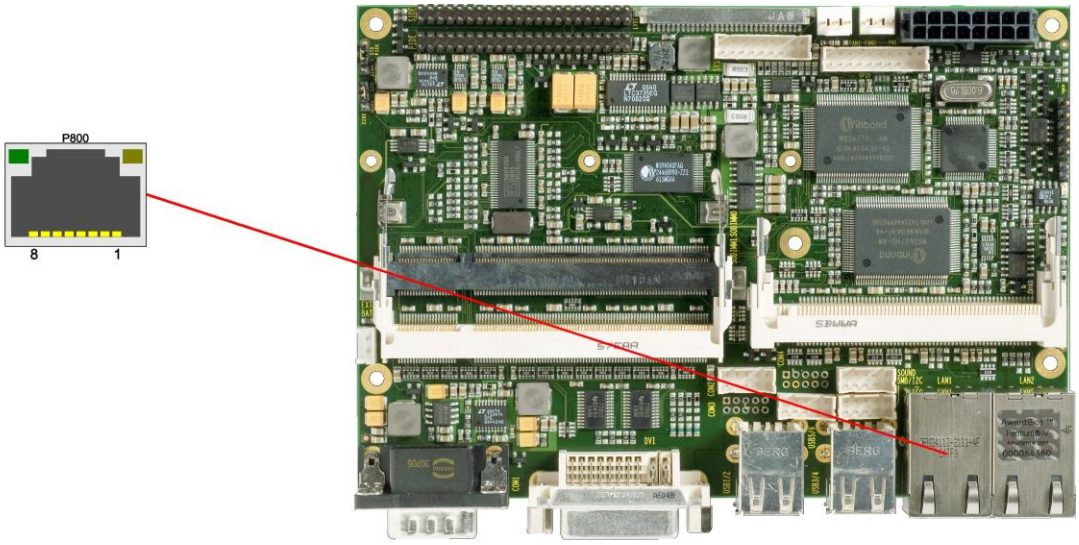
Description	Name	Pin		Name	Description
5 volt for USB5	VCC	1	6	VCC	5 volt for USB6
minus channel USB5	USB5#	2	7	USB6#	minus channel USB6
plus channel USB5	USB5	3	8	USB6	plus channel USB6
ground	GND	4	9	GND	ground
reserved	N/C	5	10	N/C	reserved

Pinout USB connector for channel X:

Pin	Name	Description
1	VCC	5 volt for USBX
2	USBX#	minus channel USBX
3	USBX	plus channel USBX
4	GND	ground

4.10 LAN1

The module has two LAN interfaces. LAN1 supports 10BaseT and 100BaseT compatible net components with automatic bandwidth selection. It also offers auto-cross and auto-negotiate functionality. The controller chip is the Intel® 82562. PXE and RPL functions are also supported.

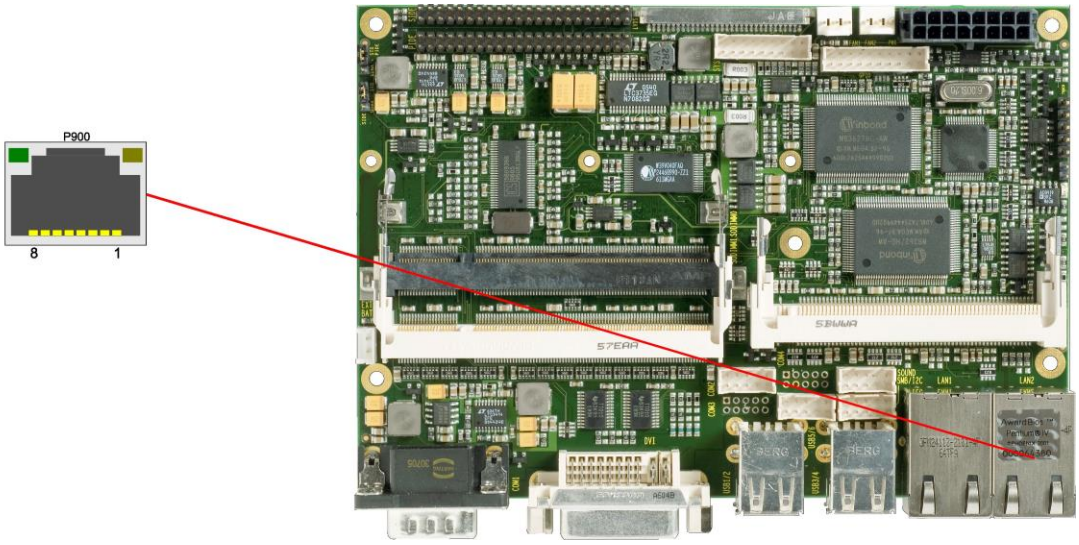


Pinout LAN 10/100:

Pin	Name	Description
1	LAN1-0	LAN1 transmit plus
2	LAN1-0#	LAN1 transmit minus
3	LAN1-1	LAN1 receive plus
4	N/C	reserved
5	N/C	reserved
6	LAN1-1#	LAN1 receive minus
7	N/C	reserved
8	N/C	reserved

4.11 LAN2

LAN2 supports 10BaseT, 100BaseT and 1000BaseT compatible net components with automatic bandwidth selection. It does not offer auto-cross and auto-negotiate functionality. The controller chip is the Intel® 82541ER. PXE and RPL functions are not supported.

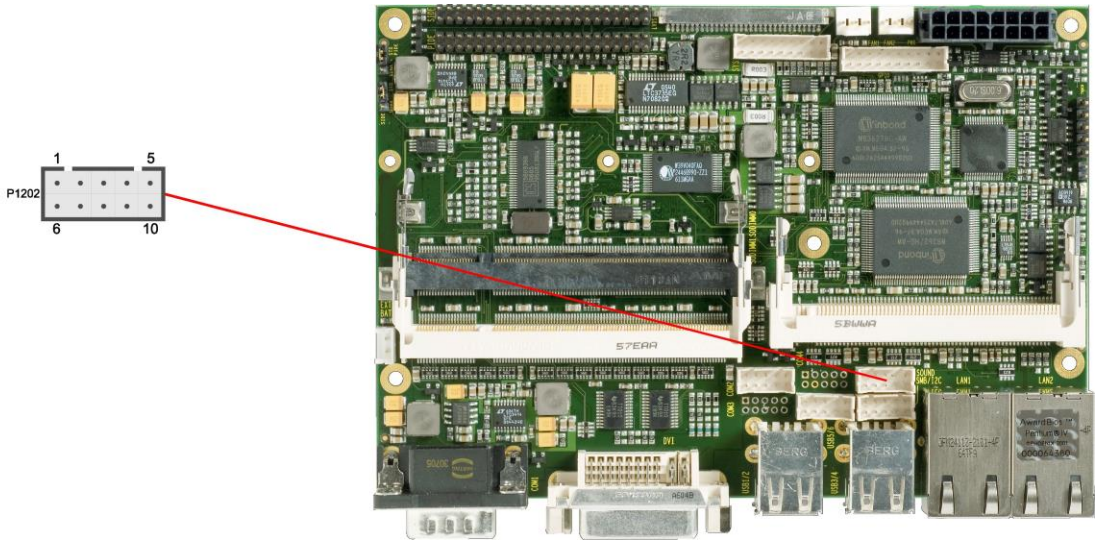


Pinout LAN 10/100/1000:

Pin	Name	Description
1	LAN2-0	LAN2 channel 0 plus
2	LAN2-0#	LAN2 channel 0 minus
3	LAN2-1	LAN2 channel 1 plus
4	LAN2-2	LAN2 channel 2 plus
5	LAN2-2#	LAN2 channel 2 minus
6	LAN2-1#	LAN2 channel 1 minus
7	LAN2-3	LAN2 channel 3 plus
8	LAN2-3#	LAN2 channel 3 minus

4.12 Audio

Audio input and output functions can be accessed via a 2x5 pin connector (JST B10B-PHDSSLFSN, mating connector: PHDR-10VS). There are two ways to use this connector. Default functionality is the familiar audio in, audio out, and microphone. OS dependent device drivers can switch these signals to support a 5.1 output; thus in this mode no audio input signals are available.
Signals "SPDIFI" and "SPDIFO" provide digital input and output. If a transformation to a coaxial or optical connector is necessary this must be performed externally.



Pinout audio 2x5 pin connector:

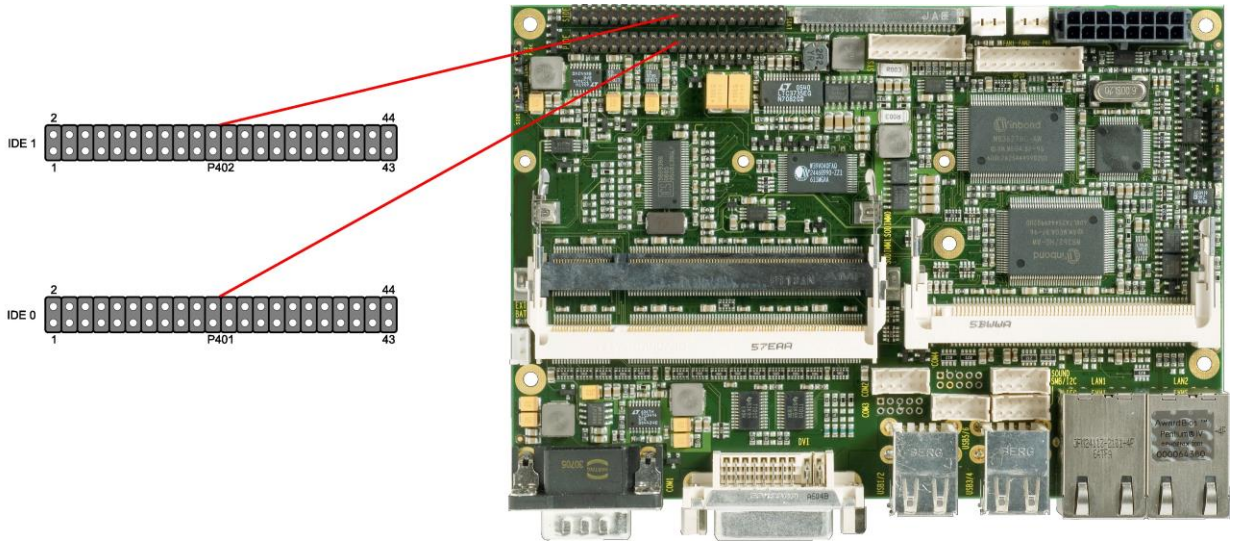
Description	Name	Pin		Name	Description
digital output SPDIF	SPDIFO	1	6	3.3V	3.3 volt supply
digital input SPDIF	SPDIFI	2	7	S_AGND	analog ground sound
sound output right / front output right	LOUT_R / FRONT_R	3	8	LOUT_L / FRONT_L	sound output left / front output left
AUX input right / rear output right	AUXA_R / REAR_R	4	9	AUXA_L / REAR_L	AUX input left / rear output left
microphone input 1 / center output	MIC1 / CENTER	5	10	MIC2 / LFE	microphone input 2 / LFE output

4.13 IDE Interfaces

The CB3050 has two IDE interfaces both provided as 2x22 pin IDC socket connectors with a spacing of 2 mm. The two sockets are located side by side with the secondary IDE interface nearer to the edge of the board (see below).
All commercial IDE devices are supported. If necessary, an adapter for a spacing of 2.54 mm must be applied. Please consult your distributor for such an adapter.
All required settings are made in the BIOS setup. If necessary, Ultra-DMA mode can be enforced by shorting a jumper (for details, see below).

NOTE

The two jumpers are positioned in the opposite way compared to their corresponding IDE sockets. The jumper nearer to the SoDIMM sockets belongs to the IDE interface farer away from it and vice versa.



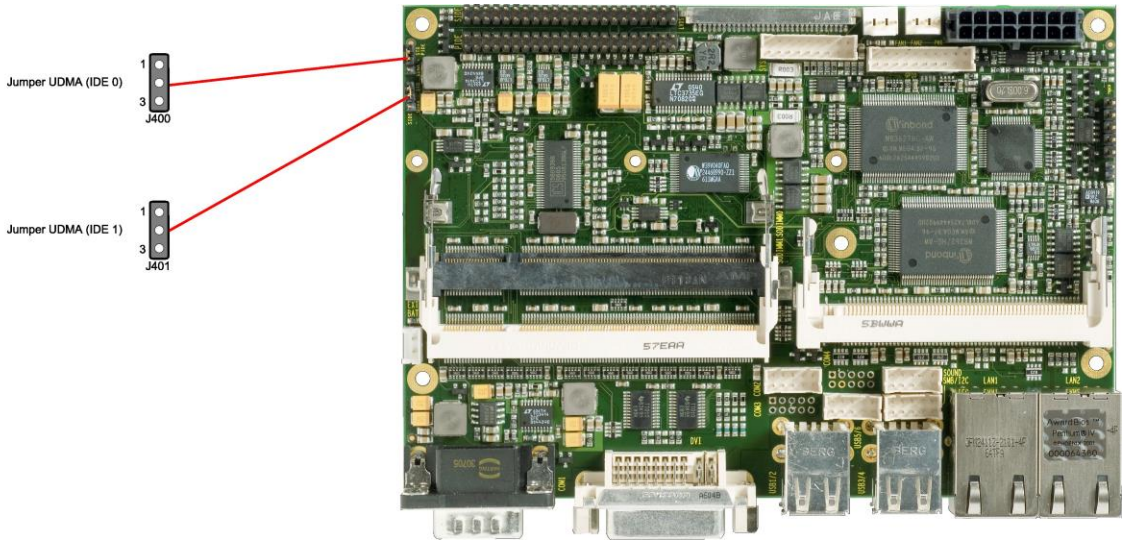
Pinout for primary IDE

Description	Name	Pin		Name	Description
reset	PRST#	1	2	GND	ground
data bit 7	PDD7	3	4	PDD8	data bit 8
data bit 6	PDD6	5	6	PDD9	data bit 9
data bit 5	PDD5	7	8	PDD10	data bit 10
data bit 4	PDD4	9	10	PDD11	data bit 11
data bit 3	PDD3	11	12	PDD12	data bit 12
data bit 2	PDD2	13	14	PDD13	data bit 13
data bit 1	PDD1	15	16	PDD14	data bit 14
data bit 0	PDD0	17	18	PDD15	data bit 15
ground	GND	19	20	N/C	reserved
DMA request signal	PDDREQ	21	22	GND	ground
write signal	PDIOW#	23	24	GND	ground
read signal	PDIOR#	25	26	GND	ground
ready signal	PDRDY	27	28	N/C	reserved
DMA acknowledge signal	PDDACK#	29	30	GND	ground
interrupt signal	PDIRQ	31	32	N/C	reserved
address bit 1	PDA1	33	34	PDMA66EN	enable UDMA66
address bit 0	PDA0	35	36	PDA2	address bit 2
chip select signal 0	PDSC0#	37	38	PDCS1#	chip select signal 1

Description	Name	Pin		Name	Description
LED	PHDLED	39	40	GND	ground
supply HDD 5V	VCC	41	42	VCC	supply HDD 5V
ground	GND	43	44	N/C	reserved

Pinout for secondary IDE

Description	Name	Pin		Name	Description
reset	SRST#	1	2	GND	ground
data bit 7	SDD7	3	4	SDD8	data bit 8
data bit 6	SDD6	5	6	SDD9	data bit 9
data bit 5	SDD5	7	8	SDD10	data bit 10
data bit 4	SDD4	9	10	SDD11	data bit 11
data bit 3	SDD3	11	12	SDD12	data bit 12
data bit 2	SDD2	13	14	SDD13	data bit 13
data bit 1	SDD1	15	16	SDD14	data bit 14
data bit 0	SDD0	17	18	SDD15	data bit 15
ground	GND	19	20	N/C	reserved
DMA request signal	SDDREQ	21	22	GND	ground
write signal	SDIOW#	23	24	GND	ground
read signal	SDIOR#	25	26	GND	ground
ready signal	SDRDY	27	28	N/C	reserved
DMA acknowledge signal	SDDACK#	29	30	GND	ground
interrupt signal	SDIRQ	31	32	N/C	reserved
address bit 1	SDA1	33	34	SDMA66EN	enable UDMA66
address bit 2	SDA0	35	36	SDA2	address bit 2
chip select signal 0	SDSC0#	37	38	SDCS1#	chip select signal 1
LED	SHDLED	39	40	GND	ground
supply HDD 5V	VCC	41	42	VCC	supply HDD 5V
ground	GND	43	44	N/C	reserved



Jumper settings: The board ships with pins 1 & 2 shorted. This is the "standard" mode which lets the IDE device and the controller negotiate the optimal transfer mode automatically. This is the best setting in most situations. However, in some cases the automatic detection results in PIO-mode transfer even though the setup would allow for UDMA. In such cases, UDMA mode can be enforced by shorting pins 2 & 3.

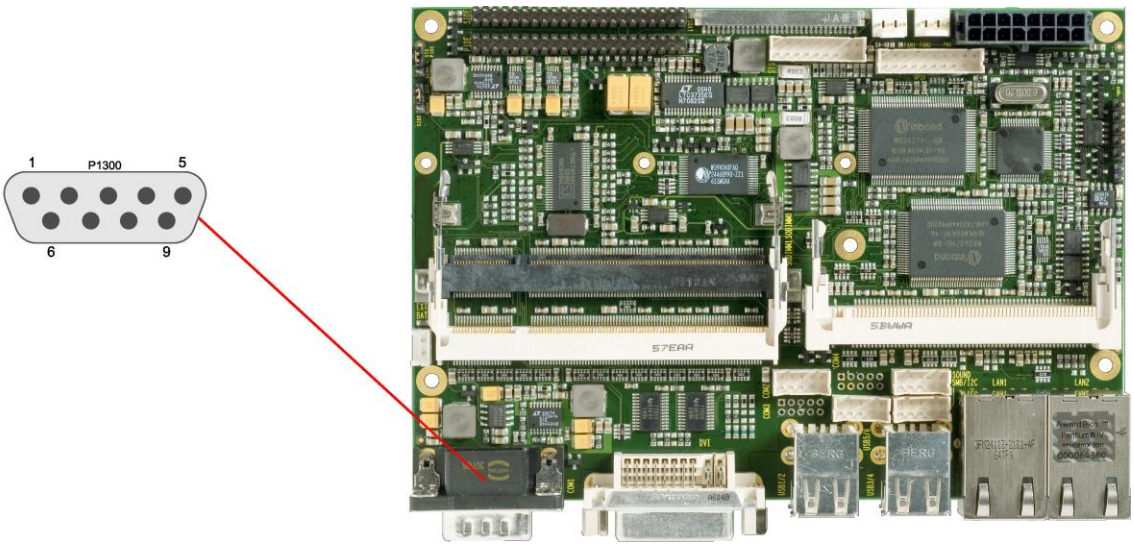
CAUTION

If you enforce UDMA mode in configurations which are not capable of running at that speed (e.g. due to inappropriate or too long cable), you'll end up with I/O-errors and loss of data!

4.14 Serial Interface COM1

The serial interface COM1 is made available via a 9-pin standard DSUB-connector. According to the product order, TTL level signals or RS232 standard signals are provided.

The port address and the interrupt are set via the BIOS setup.

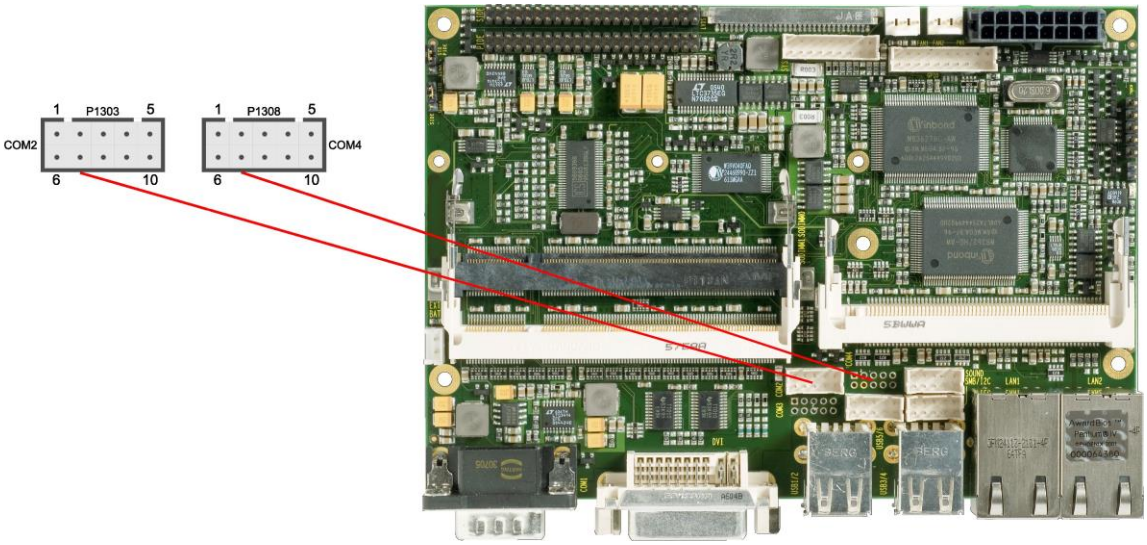


Pinout serial port (DSUB connector):

Description	Name	Pin		Name	Description
data carrier detect	DCD	1	6	DSR	data set ready
receive data	RXD	2	7	RTS	request to send
transmit data	TXD	3	8	CTS	clear to send
data terminal ready	DTR	4	9	RI	ring indicator
ground	GND	5			

4.15 Serial Ports COM2 through COM4

There are three more serial interfaces on the board. Of these, COM3 is available through the power connector (cf. p. 18). COM2 and COM4 and made available via a 2x5 pin connector each (JST B10B-PHDSSLFSN, mating connector: PHDR-10VS). However, if the board has a touch screen interface, COM4 is used internally. On these boards, the COM4 connector is either not populated or it is used for mouse and keyboard signals (see pinning below). Signals default to RS232 level but can be ordered as TTL level also.
The port address and the interrupt are set via the BIOS setup.



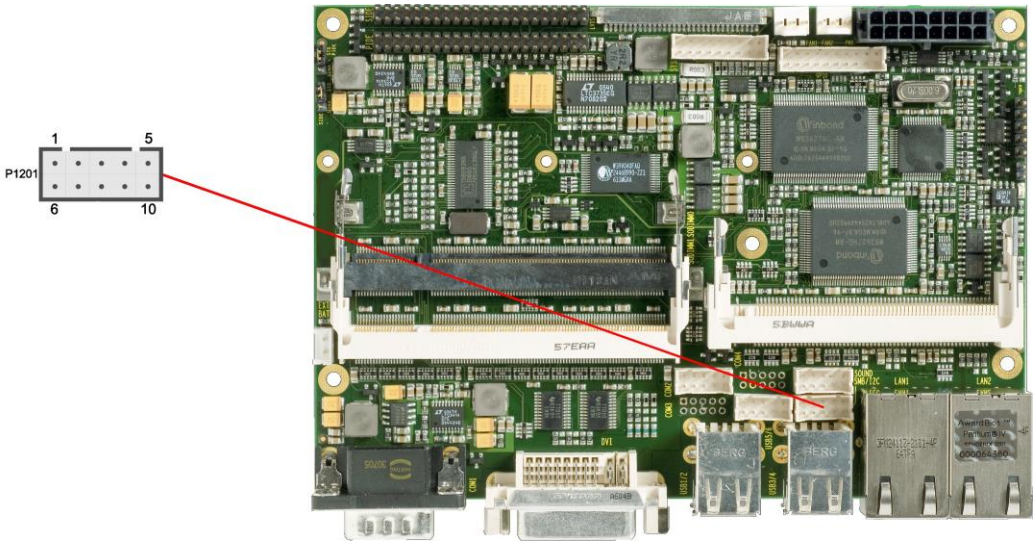
Description	Name	Pin		Name	Description
data carrier detect	DCD	1	6	DSR	data set ready
receive data	RXD	2	7	RTS	request to send
transmit data	TXD	3	8	CTS	clear to send
data terminal ready	DTR	4	9	RI	ring indicator
ground	GND	5	10	VCC	5 volt supply

Alternative pinout of COM-connector when touchscreen feature is present:

Description	Name	Pin		Name	Description
keyboard clock	KCLK	1	6	MCLK	mouse clock
keyboard data	KDAT	2	7	MDAT	mouse data
reserved	N/C	3	8	N/C	reserved
reserved	N/C	4	9	N/C	reserved
ground	GND	5	10	VCC	5 volt supply

4.16 SMB/I2C

The CB3050 can communicate with external devices via the SMBus protocol or the I2C protocol. The signals for these protocols are available through a 2x5 pin connector (JST B10B-PHDSSLFSN, mating connector: PHDR-10VS). The SMBus signals are processed by the chipset, the I2C signals are processed by the SIO unit.

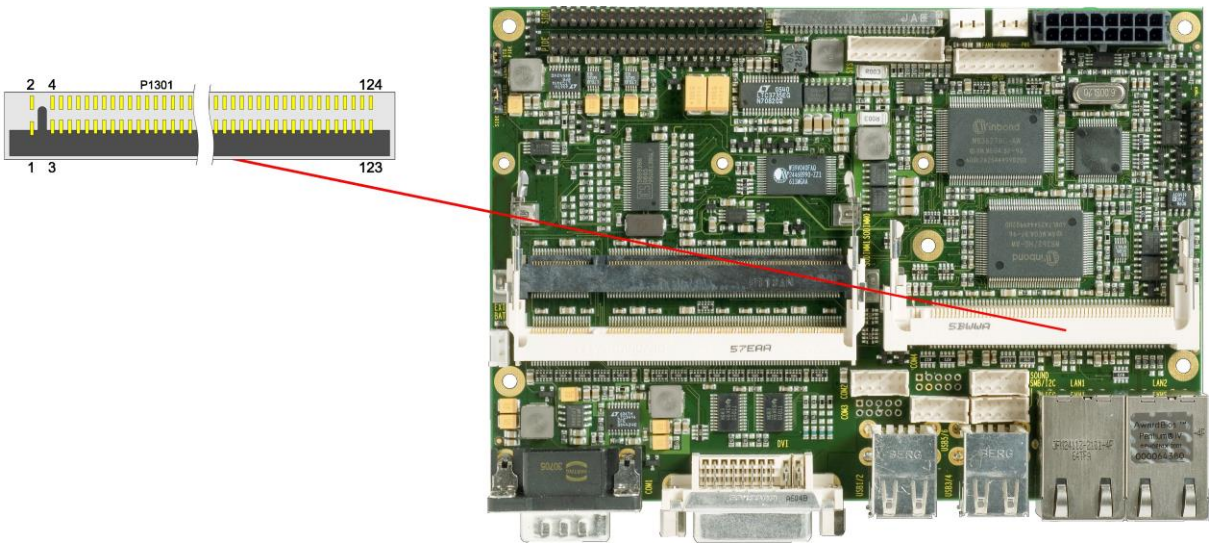


Pinout SMBus/I2C connector:

Description	Name	Pin		Name	Description
3.3 volt supply	3.3V	1	6	GND	ground
SMBus clock	SMBCLK	2	7	SMBDAT	SMBus data
SMBus alarm	SMBALRT#	3	8	SVCC	standby supply 5V
I2C bus clock	I2CLK	4	9	I2DAT	I2C bus data
5 volt supply	VCC	5	10	GND	ground

4.17 Mini-PCI

The CB3050 allows you to add expansion cards complying to the Mini-PCI standard (type III). One such card can be inserted into the Mini-PCI slot available on the board.

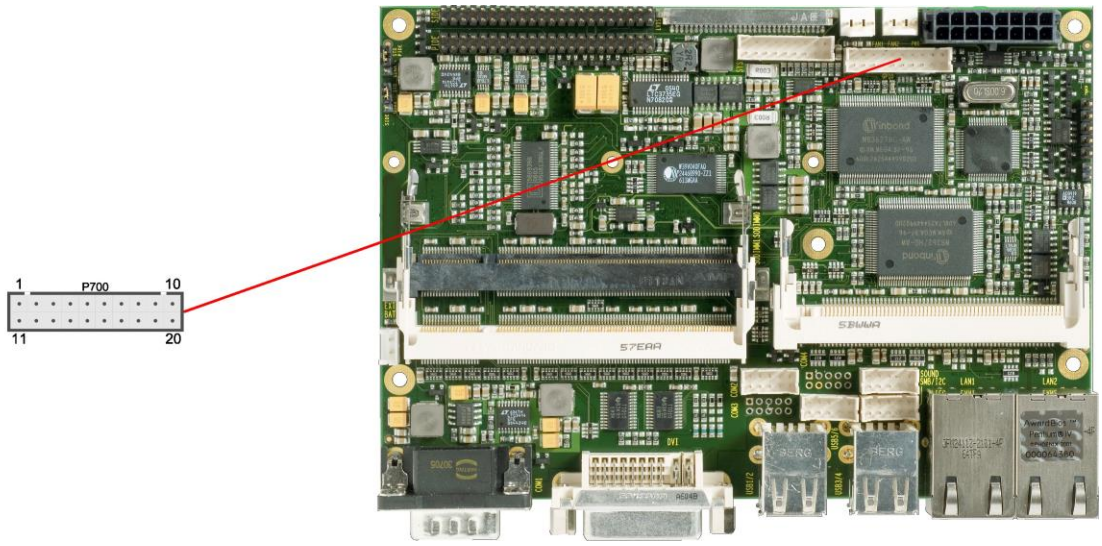


Description	Name	Pin		Name	Description
reserved	N/C	1	2	N/C	reserved
reserved	N/C	3	4	N/C	reserved
reserved	N/C	5	6	N/C	reserved
reserved	N/C	7	8	N/C	reserved
reserved	N/C	9	10	N/C	reserved
reserved	N/C	11	12	N/C	reserved
reserved	N/C	13	14	N/C	reserved
reserved	N/C	15	16	N/C	reserved
interrupt B	INTB#	17	18	VCC	5 volt supply
3.3 volt supply	3.3V	19	20	INTA#	interrupt A
serial interrupt (legacy)	SERIRQ	21	22	N/C	reserved
ground	GND	23	24	S3.3V	3.3 volt supply
PCI clock	PCLK	25	26	PRST#	reset
ground	GND	27	28	3.3V	3.3 volt supply
PCI request	REQ#	29	30	GNT#	PCI grant
3.3 volt supply	3.3V	31	32	GND	ground
address/data 31	AD31	33	34	PME#	power management event
address/data 29	AD29	35	36	N/C	reserved
ground	GND	37	38	AD30	address/data 30
address/data 27	AD27	39	40	3.3V	3.3 volt supply
address/data 25	AD25	41	42	AD28	address/data 28
interrupt C	INTC#	43	44	AD26	address/data 26
bus cmd/byte enables 3	CBE3#	45	46	AD24	address/data 24
address/data 23	AD23	47	48	IDSEL	init device select
ground	GND	49	50	GND	ground
address/data 21	AD21	51	52	AD22	address/data 22
address/data 19	AD19	53	54	AD20	address/data 20
ground	GND	55	56	PAR	parity
address/data 17	AD17	57	58	AD18	address/data 18

Description	Name	Pin		Name	Description
bus cmd/byte enables 2	CBE2#	59	60	AD16	address/data 16
initiator ready	IRDY#	61	62	GND	ground
3.3 volt supply	3.3V	63	64	FRAME#	cycle frame
clock running	CLKRUN#	65	66	TRDY#	target ready
system error	SERR#	67	68	STOP#	stop request by target
ground	GND	69	70	3.3V	3.3 volt supply
parity error	PERR#	71	72	DEVSEL#	device select
bus cmd/byte enables 1	CBE1#	73	74	GND	ground
address/data 14	AD14	75	76	AD15	address/data 15
ground	GND	77	78	AD13	address/data 13
address/data 12	AD12	79	80	AD11	address/data 11
address/data 10	AD10	81	82	GND	ground
ground	GND	83	84	AD9	address/data 9
address/data 8	AD8	85	86	CBE0#	bus cmd/byte enables 0
address/data 7	AD7	87	88	3.3V	3.3 volt supply
3.3 volt supply	3.3V	89	90	AD6	address/data 6
address/data 5	AD5	91	92	AD4	address/data 4
interrupt D	INTD#	93	94	AD2	address/data 2
address/data 3	AD3	95	96	AD0	address/data 0
5 volt supply	VCC	97	98	N/C	reserved
address/data 1	AD1	99	100	N/C	reserved
ground	GND	101	102	GND	ground
reserved	N/C	103	104	GND	ground
reserved	N/C	105	106	N/C	reserved
reserved	N/C	107	108	N/C	reserved
reserved	N/C	109	110	N/C	reserved
reserved	N/C	111	112	N/C	reserved
reserved	N/C	113	114	GND	ground
reserved	N/C	115	116	N/C	reserved
reserved	N/C	117	118	N/C	reserved
reserved	N/C	119	120	N/C	reserved
lock	PLOCK#	121	122	N/C	reserved
reserved	N/C	123	124	S3.3V	3.3 volt supply

4.18 GPIO

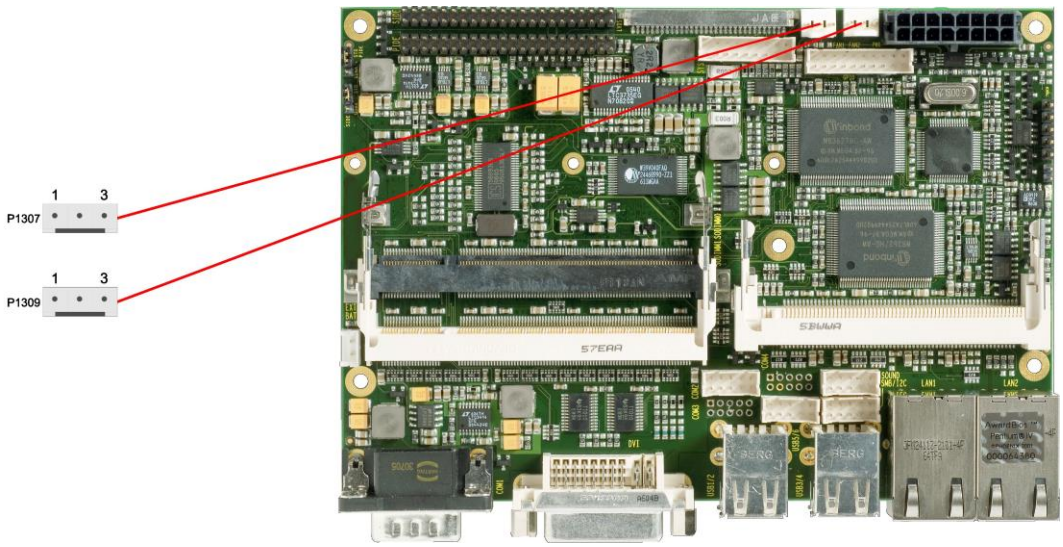
The General Purpose Input/Output interface is made available through a 2x10 pin connector (JST B20B-PHDSSLFSN, mating connector: PHDR-20VS). To make use of this interface the SIO unit must be programmed accordingly. Please refer to your distributor for information on available software support.



Description	Name	Pin		Name	Description
5 volt supply	VCC	1	11	VCC	5 volt supply
GP input/output 10	GPIO10	2	12	GPIO20	GP input/output 20
GP input/output 11	GPIO11	3	13	GPIO21	GP input/output 21
GP input/output 12	GPIO12	4	14	GPIO22	GP input/output 22
GP input/output 13	GPIO13	5	15	GPIO23	GP input/output 23
GP input/output 14	GPIO14	6	16	GPIO24	GP input/output 24
GP input/output 15	GPIO15	7	17	GPIO25	GP input/output 25
GP input/output 16	GPIO16	8	18	GPIO26	GP input/output 26
GP input/output 17	GPIO17	9	19	GPIO27	GP input/output 27
ground	GND	10	20	GND	ground

4.19 Fan Connectors

Two 3 pin connectors are available for controlling and monitoring external fans (12 volt). For the monitoring the fans must provide a corresponding speed signal.



Pinout fan connector:

Pin	Name	Description
1	GND	ground
2	12V	12 volt supply regulated
3	TACHO	fan monitoring signal

5 BIOS Settings

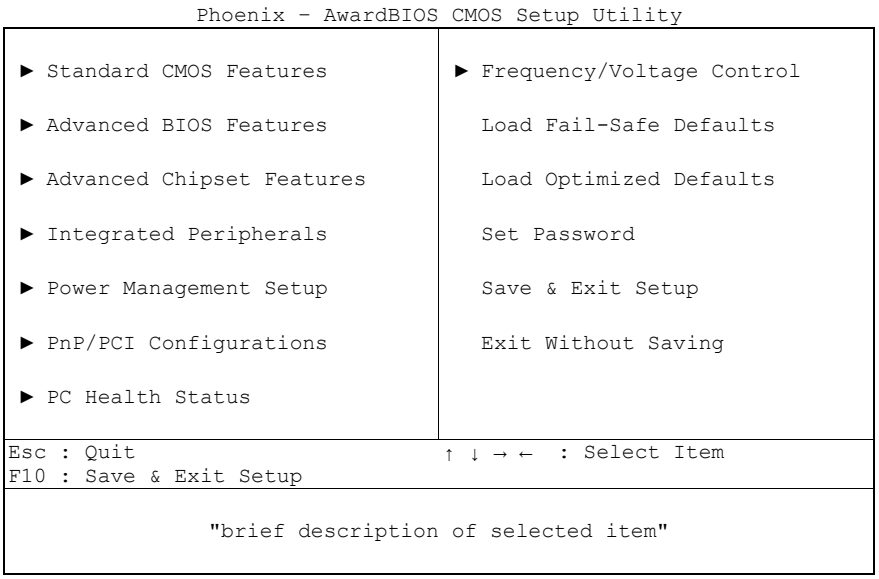
5.1 Remarks for Setup Use

In a setup page, standard values for its setup entries can be loaded. Fail-safe defaults are loaded with F6 and optimized defaults are loaded with F7. These standard values are independent of the fact that a board has successfully booted with a setup setting before.
This is different if these defaults are called from the Top Menu. Once a setup setting was saved, which subsequently leads to a successful boot process, those values are loaded as default for all setup items afterwards.
See also the chapters “Load Fail-Safe Defaults" (5.10) and “Load Optimized Defaults” (5.11).

NOTE

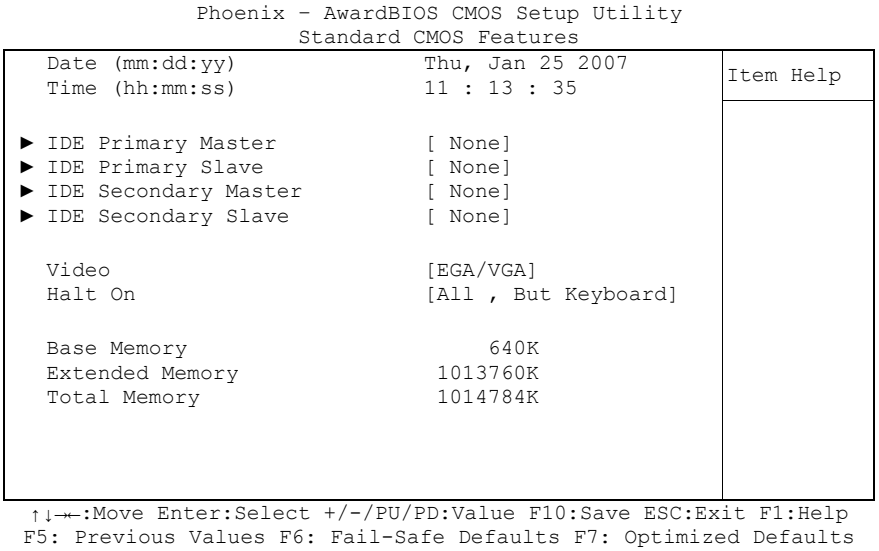
BIOS features and setup options are subject to change without notice. The settings displayed in the screenshots on the following pages are meant to be examples only. They do not represent the recommended settings or the default settings. Determination of the appropriate settings is dependent upon the particular application scenario in which the board is used.

5.2 Top Level Menu



The sign „►“ in front of an item means that there is a sub menu.
The „x“ sign in front of an item means, that the item is disabled but can be enabled by changing or selecting some other item (usually somewhere above the disabled item on the same screen).
Use the arrow buttons to navigate from one item to another. For selecting an item press Enter which will open either a sub menu or a dialog screen.

5.3 Standard CMOS Features



- ✓ **Date (mm:dd:yy)**
  Options: mm: month
  dd: day
  yy: year

- ✓ **Time (hh:mm:ss)**
  Options: hh: hours
  mm: minutes
  ss: seconds

- ✓ **IDE Primary Master**
  Sub menu: see "IDE Primary Master/Slave" (page 43)

- ✓ **IDE Primary Slave**
  Sub menu: see "IDE Primary Master/Slave" (page 43)

- ✓ **IDE Secondary Master**
  Sub menu: see "IDE Primary Master/Slave" (page 43)

- ✓ **IDE Secondary Slave**
  Sub menu: see "IDE Primary Master/Slave" (page 43)

- ✓ **Video**
  Options: EGA/VGA / CGA 40 / CGA 80 / Mono

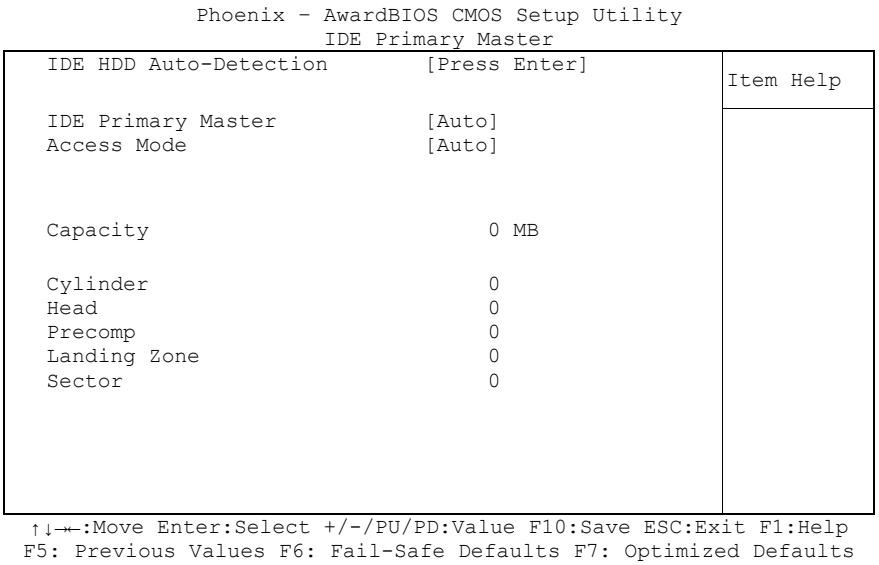
- ✓ **Halt On**
  Options: All Errors / No Errors / All, But Keyboard

- ✓ **Base Memory**
  Options: none

- ✓ **Extended Memory**
  Options: none

- ✓ **Total Memory**
  Options: none

5.3.1 IDE Primary Master/Slave



- ✓ **IDE HDD Auto-Detection**
  Options: none
- ✓ **IDE Primary Master**
  Options: None / Auto / Manual
- ✓ **Access Mode**
  Options: CHS / LBA / Large / Auto
- ✓ **Capacity**
  Options: none
- ✓ **Cylinder**
  Options: none
- ✓ **Head**
  Options: none
- ✓ **Precomp**
  Options: none
- ✓ **Landing Zone**
  Options: none
- ✓ **Sector**
  Options: none

5.4 Advanced BIOS Features

```
                Phoenix – AwardBIOS CMOS Setup Utility
                      Advanced BIOS Features
┌──────────────────────────────────────────────┬──────────────┐
│ ► CPU Feature                [Press Enter]   │ Item Help    │
│   Virus Warning              [Disabled]      │              │
│   CPU L1 & L2 Cache          [Enabled]       │              │
│   Quick Power On Self Test   [Enabled]       │              │
│   First Boot Device          [HDD-0]         │              │
│   Second Boot Device         [Disabled]      │              │
│   Third Boot Device          [Disabled]      │              │
│   Boot Other Device          [Enabled]       │              │
│   Boot Up NumLock Status     [On]            │              │
│   Gate A20 Option            [Fast]          │              │
│   Typematic Rate Setting     [Disabled]      │              │
│ x Typematic Rate (Chars/Sec)  6              │              │
│ x Typematic Delay (Msec)      250            │              │
│   Security Option            [Setup]         │              │
│   APIC Mode                  [Disabled]      │              │
│   MPS Version Control For OS 1.4             │              │
│   OS Select For DRAM > 64MB  [Non OS2]       │              │
│   HDD S.M.A.R.T. Capability  [Enabled]       │              │
│   Report No FDD For WIN 95   [No]            │              │
│   Full Screen LOGO Show      [Disabled]      │              │
└──────────────────────────────────────────────┴──────────────┘
  ↑↓→←:Move Enter:Select +/-/PU/PD:Value F10:Save ESC:Exit F1:Help
 F5: Previous Values F6: Fail-Safe Defaults F7: Optimized Defaults
```

- ✓ **CPU Feature**
  Sub menu: see "CPU Feature" (page 46)

- ✓ **Virus Warning**
  Options: Enabled / Disabled

- ✓ **CPU L1 & L2 Cache**
  Options: Enabled / Disabled

- ✓ **Quick Power On Self Test**
  Options: Enabled / Disabled

- ✓ **First Boot Device**
  Options: LS120 / HDD-0 / SCSI / CDROM / HDD-1 / HDD-2 / HDD-3 / ZIP100 / USB-FDD / USB-ZIP / USB-CDROM / USB-HDD / LAN / Disabled

- ✓ **Second Boot Device**
  Options: LS120 / HDD-0 / SCSI / CDROM / HDD-1 / HDD-2 / HDD-3 / ZIP100 / USB-FDD / USB-ZIP / USB-CDROM / USB-HDD / LAN / Disabled

- ✓ **Third Boot Device**
  Options: LS120 / HDD-0 / SCSI / CDROM / HDD-1 / HDD-2 / HDD-3 / ZIP100 / USB-FDD / USB-ZIP / USB-CDROM / USB-HDD / LAN / Disabled

- ✓ **Boot Other Device**
  Options: Enabled / Disabled

- ✓ **Boot Up NumLock Status**
  Options: Off / On

- ✓ **Gate A20 Option**
  Options: Normal / Fast

- ✓ **Typematic Rate Setting**
  Options: Enabled / Disabled

- ✓ **Typematic Rate (Chars/Sec)**
  Options: 6 / 8 / 10 / 12 / 15 / 20 / 24 / 30

- ✓ **Typematic Delay (Msec)**
  Options: 250 / 500 / 750 / 1000

- ✓ **Security Option**
  Options: Setup / System

- ✓ **APIC Mode**
  Options: Enabled / Disabled

- ✓ **MPS Version Control For OS**
  Options: 1.1 / 1.4

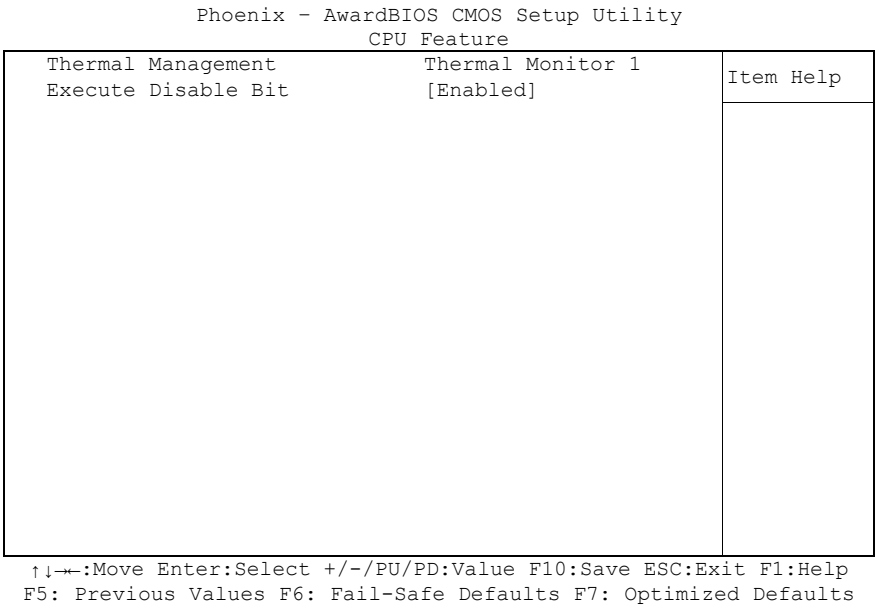
- ✓ **OS Select For DRAM > 64MB**
  Options: Non-OS2 / OS2

- ✓ **HDD S.M.A.R.T. Capability**
  Options: Enabled / Disabled

- ✓ **Report No FDD For WIN 95**
  Options: No / Yes

- ✓ **Full Screen LOGO Show**
  Options: Enabled / Disabled

5.4.1 CPU Feature



- ✓ **Thermal Management**
  Options: none

- ✓ **Execute Disable Bit**
  Options: Enabled / Disabled

5.5 Advanced Chipset Features

```
                    Phoenix – AwardBIOS CMOS Setup Utility
                        Advanced Chipset Features
  DRAM Timing Selectable          [By SPD]          | Item Help
x CAS Latency Time                 2.5               |
x Active to Precharge Delay       7                  |
x DRAM RAS# to CAS# Delay         3                  |
x DRAM RAS# Precharge             3                  |
x DRAM Data Integrity Mode        Non-ECC            |
  MGM Core Frequency              [Auto Max 266MHz]  |
  System BIOS Cacheable           [Enabled]          |
  Video BIOS Cacheable            [Enabled]          |
  Memory Hole At 15M-16M          [Disabled]         |
  Delayed Transaction             [Enabled]          |
  Delay Prior to Thermal          [16 Min]           |
  AGP Aperture Size (MB)          [64]               |
  ** On-Chip VGA Setting **                          |
  On-Chip VGA                     [Enabled]          |
  On-Chip Frame Buffer Size       [32MB]             |
  Boot Display                    [LFP]              |
  Panel Scaling                   [Off]              |
  Panel Number                    [ 800*600 *18b-sp] |
↑↓→←:Move Enter:Select +/-/PU/PD:Value F10:Save ESC:Exit F1:Help
F5: Previous Values F6: Fail-Safe Defaults F7: Optimized Defaults
```

- ✓ **DRAM Timing Selectable**
  Options: By SPD / Manual

- ✓ **CAS Latency Time**
  Options: 2.5 / 2

- ✓ **Active to Precharge Delay**
  Options: 5 / 6 / 7

- ✓ **DRAM RAS# to CAS# Delay**
  Options: 2 / 3

- ✓ **DRAM RAS# Precharge**
  Options: 2 / 3

- ✓ **DRAM Data Integrity Mode**
  Options: none

- ✓ **MGM Core Frequency**
  Options: Auto Max 266MHz /
  400/266/133/200 MHz /
  400/200/100/200 MHz /
  400/200/100/133 MHz /
  400/266/133/267 MHz /
  400/333/166/250 MHz /
  Auto Max 400/333 MHz

- ✓ **System BIOS Cacheable**
  Options: Enabled / Disabled

- ✓ **Video BIOS Cacheable**
  Options: Enabled / Disabled

- ✓ **Memory Hole At 15M-16M**
  Options: Enabled / Disabled

- ✓ **Delayed Transaction**
  Options: Enabled / Disabled

- ✓ **Delay Prior to Thermal**
  Options: 4 Min / 8 Min / 16 Min / 32 Min

- ✓ **AGP Aperture Size**
  Options: 4 / 8 / 16 / 32 / 64 / 128 / 256

- ✓ **On Chip VGA**
  Options: Enabled / Disabled

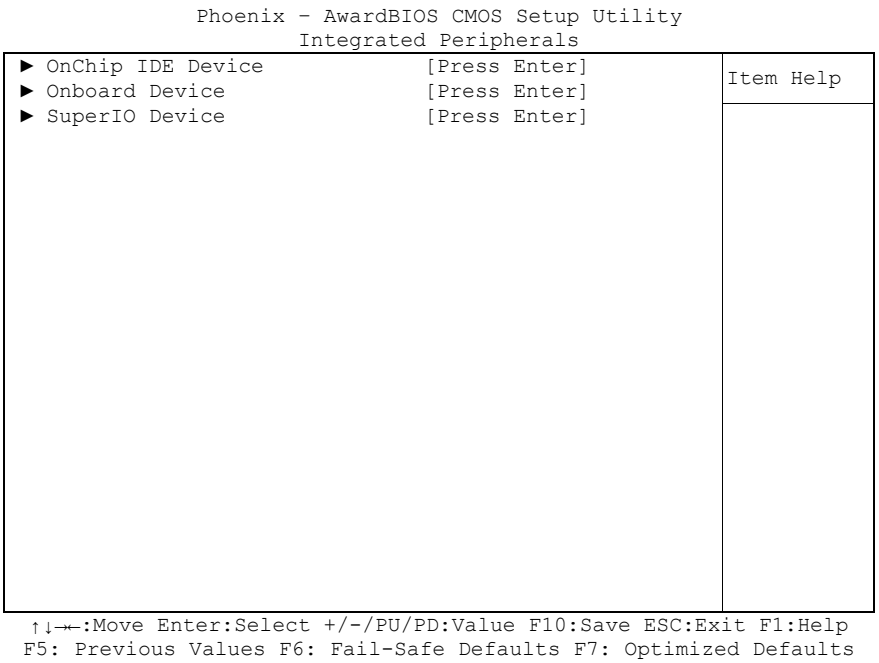
- ✓ **On Chip Frame Buffer Size**
  Options: 1MB / 4MB / 8MB / 16MB / 32MB

- ✓ **Boot Display**
  Options: VBIOS Default / CRT / LFP / CRT+LFP / EFP / CRT+EFP

- ✓ **Panel Scaling**
  Options: Auto / On / Off

- ✓ **Panel Number**
  Options: 640*480 *18b-sp / 800*600 *18b-sp / 1024*768 *18b-sp / 1024*768 *18b-dp / 1280*1024*18b-dp / 1400*1050*18b-dp / 1400*1050*18b-rb / 1600*1200*18b-dp / 640*480 *24b-sp / 800*600 *24b-sp / 1024*768 *24b-sp / 1024*768 *24b-dp / 1280*1024*24b-dp / 1400*1050*24b-dp / 1400*1050*24b-rb / 1600*1200*24b-dp

5.6 Integrated Peripherals

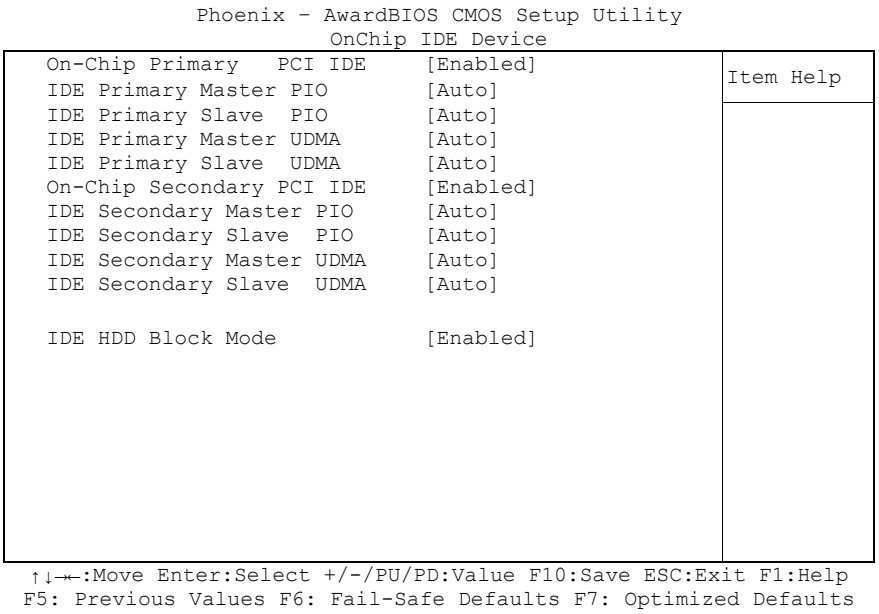


- ✓ **OnChip IDE Device**
  Sub menu: see "OnChip IDE Devices" (page 50)

- ✓ **Onboard Device**
  Sub menu: see "Onboard Devices" (page 51)

- ✓ **SuperIO Device**
  Sub menu: see "SuperIO Devices" (page 52)

5.6.1 OnChip IDE Devices



- ✓ **On-Chip Primary PCI IDE**
  Options: Enabled / Disabled

- ✓ **IDE Primary Master PIO**
  Options: Auto / Mode 0 / Mode 1 / Mode 2 / Mode 3 / Mode 4

- ✓ **IDE Primary Slave PIO**
  Options: Auto / Mode 0 / Mode 1 / Mode 2 / Mode 3 / Mode 4

- ✓ **IDE Primary Master UDMA**
  Options: Disabled / Auto

- ✓ **IDE Primary Slave UDMA**
  Options: Disabled / Auto

- ✓ **On-Chip Secondary PCI IDE**
  Options: Enabled / Disabled

- ✓ **IDE Secondary Master PIO**
  Options: Auto / Mode 0 / Mode 1 / Mode 2 / Mode 3 / Mode 4

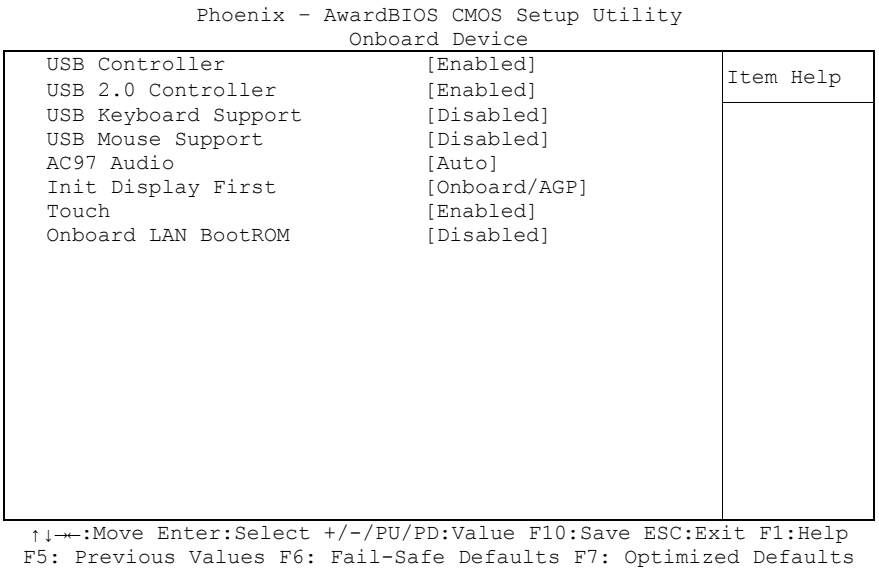
- ✓ **IDE Secondary Slave PIO**
  Options: Auto / Mode 0 / Mode 1 / Mode 2 / Mode 3 / Mode 4

- ✓ **IDE Secondary Master UDMA**
  Options: Disabled / Auto

- ✓ **IDE Secondary Slave UDMA**
  Options: Disabled / Auto

- ✓ **IDE HDD Block Mode**
  Options: Enabled / Disabled

5.6.2 Onboard Devices



- ✓ **USB Controller**
  Options: Enabled / Disabled

- ✓ **USB 2.0 Controller**
  Options: Enabled / Disabled

- ✓ **USB Keyboard Support**
  Options: Enabled / Disabled

- ✓ **USB Mouse Support**
  Options: Enabled / Disabled

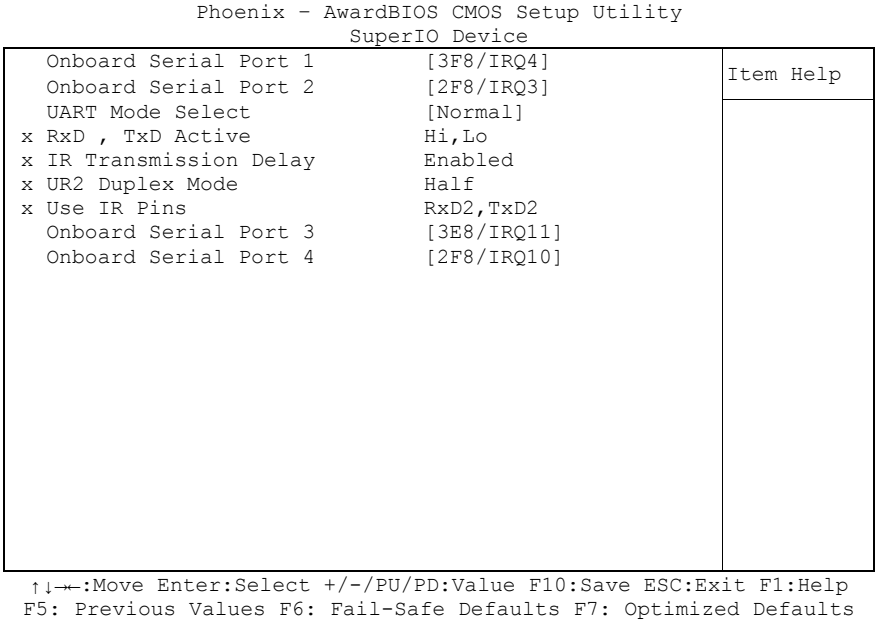
- ✓ **AC97 Audio**
  Options: Disabled / Auto

- ✓ **Init Display First**
  Options: Onboard/AGP / PCI Slot

- ✓ **Touch**
  Options: Enabled / Disabled

- ✓ **Onboard LAN BootROM**
  Options: Enabled / Disabled

5.6.3 SuperIO Devices



- ✓ **Onboard Serial Port 3**
  Options: Disabled / 3F8/IRQ11 / 2F8/IRQ11 / 3E8/IRQ11 / 2E8/IRQ11

- ✓ **Onboard Serial Port 4**
  Options: Disabled / 3F8/IRQ10 / 2F8/IRQ10 / 3E8/IRQ10 / 2E8/IRQ10

- ✓ **Onboard Serial Port 1**
  Options: Disabled / 3F8/IRQ4 / 2F8/IRQ3 / 3E8/IRQ4 / 2E8/IRQ3 / Auto

- ✓ **Onboard Serial Port 2**
  Options: Disabled / 3F8/IRQ4 / 2F8/IRQ3 / 3E8/IRQ4 / 2E8/IRQ3 / Auto

- ✓ **UART Mode Select**
  Options: IrDA / ASKIR / Normal

- ✓ **RxD , TxD Active**
  Options: Hi,Hi / Hi,Lo / Lo,Hi / Lo,Lo

- ✓ **IR Transmission Delay**
  Options: Enabled / Disabled

- ✓ **UR2 Duplex Mode**
  Options: Full / Half

- ✓ **Use IR Pins**
  Options: RxD2,TxD2 / IR-Rx2Tx2

5.7 Power Management Setup

```
                    Phoenix – AwardBIOS CMOS Setup Utility
                          Power Management Setup
  ACPI Function                 [Enabled]          | Item Help
  ACPI Suspend Type             [S1(POS)]          |
  Run VGABIOS if S3 Resume       Yes               |
  Power Management              [User Define]      |
  Video Off Method              [DPMS]             |
  Video Off in Suspend          [Yes]              |
  Suspend Type                  [Stop Grant]       |
  Modem Use IRQ                 [3]                |
  Suspend Mode                  [Disabled]         |
  HDD Power Down                [Disabled]         |
  Soft-Off by PWR-BTTN          [Instant-Off]      |
  PWRON After PWR-Fail          [On]               |
  Wake-Up by PCI card           [Disabled]         |
  Power On by Ring              [Disabled]         |
x USB KB Wake-Up From S3         Disabled          |
  Resume by Alarm               [Disabled]         |
x  Date(of Month) Alarm           0                 |
x  Time(hh:mm:ss)                 0 : 0 : 0         |
                                                    |
↑↓→←:Move Enter:Select +/-/PU/PD:Value F10:Save ESC:Exit F1:Help
F5: Previous Values F6: Fail-Safe Defaults F7: Optimized Defaults
```

- ✓ **ACPI function**
  Options: Enabled / Disabled

- ✓ **ACPI Suspend Type**
  Options: S1(POS) / S3(STR) / S1&S3

- ✓ **Run VGABIOS if S3 Resume**
  Options: Auto / Yes / No

- ✓ **Power Management**
  Options: User Define / Min Saving / Max Saving

- ✓ **Video Off Method**
  Options: Blank Screen / V/H SYNC+Blank / DPMS

- ✓ **Video Off In Suspend**
  Options: No / Yes

- ✓ **Suspend Type**
  Options: Stop Grant / PwrOn Suspend

- ✓ **MODEM Use IRQ**
  Options: NA / 3 / 4 / 5 / 7 / 9 / 10 / 11

- ✓ **Suspend Mode**
  Options: Disabled / 1 Min / 2 Min / 4 Min / 8 Min / 12 Min / 20 Min / 30 Min / 40 Min / 1 Hour

- ✓ **HDD Power Down**
  Options: Disabled / 1 Min ... 15 Min

- ✓ **Soft-Off by PWR-BTTN**
  Options: Instant-Off / Delay 4 Sec

- ✓ **PWRON After PWR-Fail**
  Options: Former Sts / On / Off

- ✓ **Wake Up by PCI Card**
  Options: Enabled / Disabled

- ✓ **Power-On by Ring**
  Options: Enabled / Disabled

- ✓ **USB KB Wake Up From S3**
  Options: Enabled / Disabled

- ✓ **Resume by Alarm**
  Options: Enabled / Disabled

- ✓ **Date(of Month) Alarm**
  Options: 1 / ... / 31

- ✓ **Time (hh:mm:ss) Alarm**
  Options: insert [hh], [mm] and [ss]

- ✓ **Primary IDE 0**
  Options: Enabled / Disabled

- ✓ **Primary IDE 1**
  Options: Enabled / Disabled

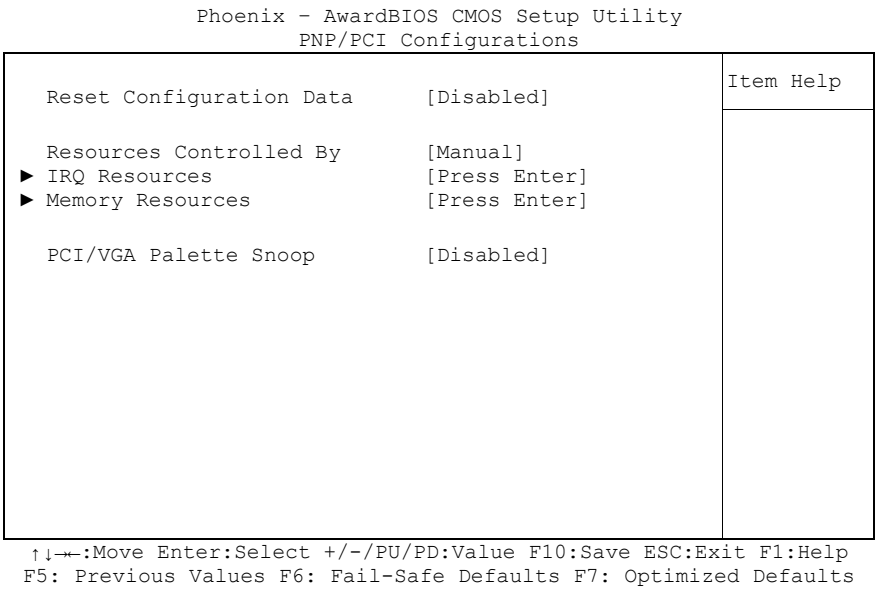
- ✓ **Secondary IDE 0**
  Options: Enabled / Disabled

- ✓ **Secondary IDE 1**
  Options: Enabled / Disabled

- ✓ **FDD,COM,LPT Port**
  Options: Enabled / Disabled

- ✓ **PCI PIRQ[A-D]#**
  Options: Enabled / Disabled

5.8 PnP/PCI Configuration



- ✓ **Reset Configuration Data**
  Options: Enabled / Disabled

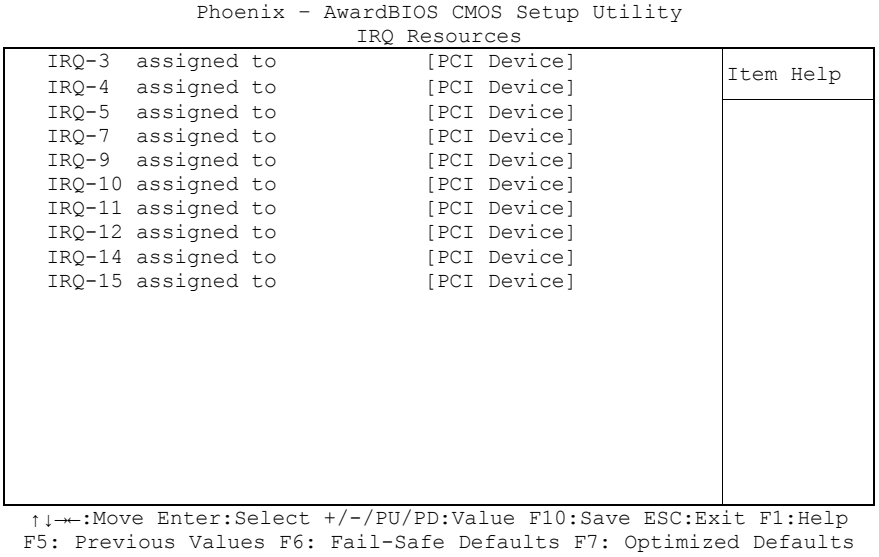
- ✓ **Resources Controlled By**
  Options: Auto(ESCD) / Manual

- ✓ **IRQ Resources**
  Sub menu: see "IRQ Resources" (page 56)

- ✓ **Memory Resources**
  Sub menu: see "Memory Resources" (page 57)

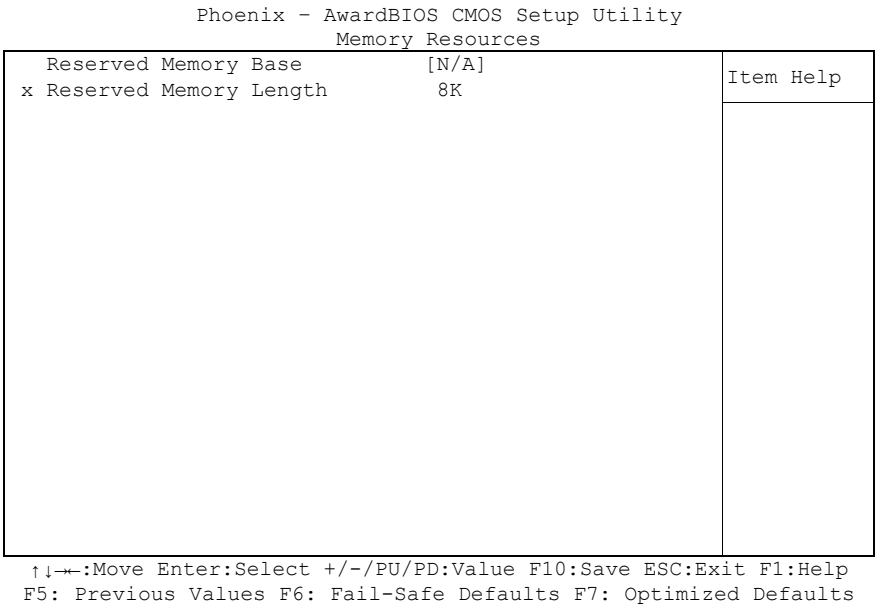
- ✓ **PCI/VGA Palette Snoop**
  Options: Enabled / Disabled

5.8.1 IRQ Resources



- ✓ **IRQ-3 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-4 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-5 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-7 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-9 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-10 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-11 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-12 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-14 assigned to**
  Options: PCI Device / Reserved
- ✓ **IRQ-15 assigned to**
  Options: PCI Device / Reserved

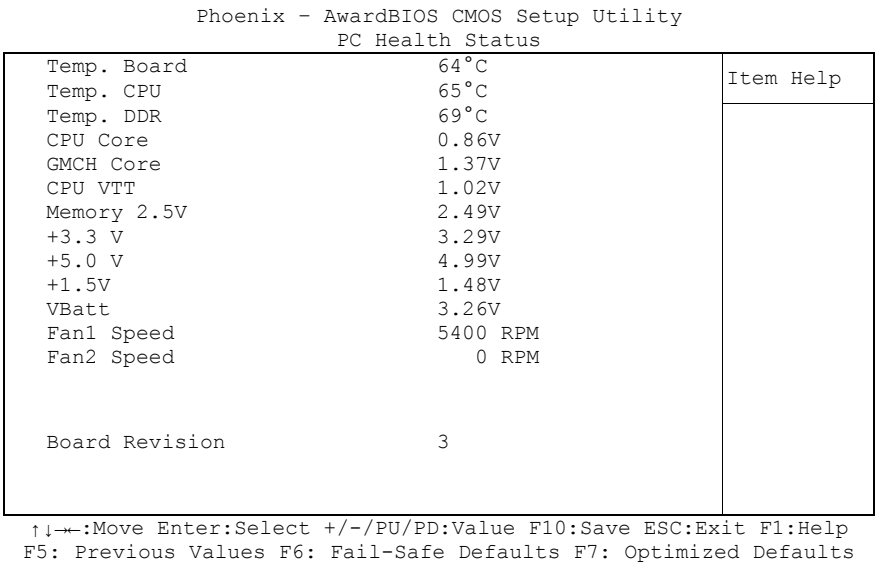
5.8.2 Memory Resources



- ✓ **Reserved Memory Base**
  Options: N/A / D000 / D800

- ✓ **Reserved Memory Length**
  Options: 8K / 16K / 32K

5.9 PC Health Status

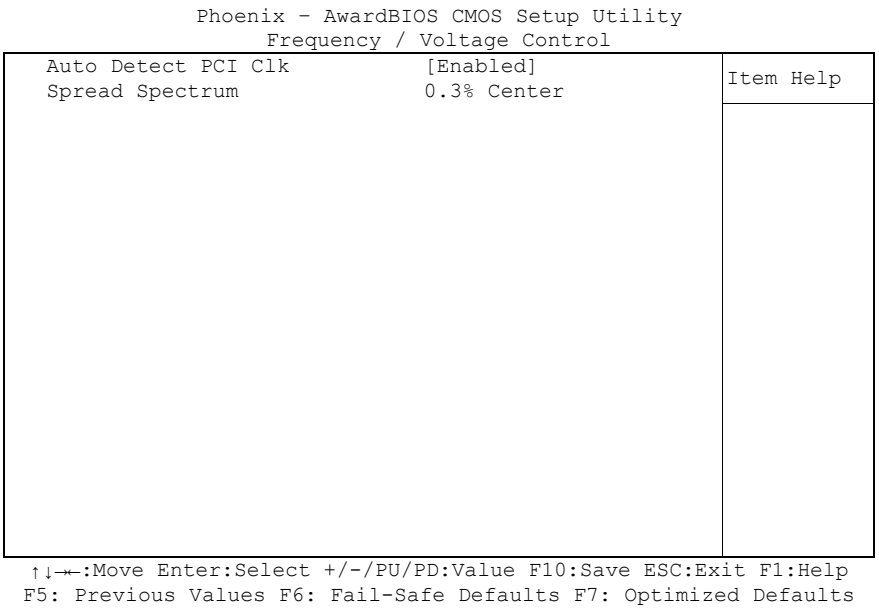


- ✓ **Temp. Board**
  Options: none
- ✓ **Temp. CPU**
  Options: none
- ✓ **Temp. DDR**
  Options: none
- ✓ **CPU Core**
  Options: none
- ✓ **GMCH Core**
  Options: none
- ✓ **CPU VTT**
  Options: none
- ✓ **Memory 2.5V**
  Options: none
- ✓ **+3.3 V**
  Options: none
- ✓ **+5.0 V**
  Options: none
- ✓ **+1.5 V**
  Options: none
- ✓ **VBatt**
  Options: none
- ✓ **Fan1 Speed**
  Options: none

- ✓ **Fan2 Speed**
  Options: none

- ✓ **Board Revision**
  Options: none

5.10 Frequency/Voltage Control



- ✓ **Auto Detect PCI Clk**
  Options: Enabled / Disabled

- ✓ **Spread Spectrum**
  Options: none

5.11 Load Fail-Safe Defaults

If this option is chosen, the last working setup is loaded from flash. Working means that the setup setting has already led to a successful boot process.
At the first setting of the BIOS setup, safe values are loaded which lets the board boot. This status is reached again, if the board is reprogrammed with the corresponding flash-program and the required parameters.

5.12 Load Optimized Defaults

This option applies like described under “Remarks for Setup Use” (5.1).
At first start of the BIOS, optimized values are loaded from the setup, which are supposed to make the board boot. This status is achieved again, if the board is reprogrammed using the flash program with the required parameters.

5.13 Set Password

Here you can enter a password to protect the BIOS settings against unauthorized changes. Use this option with care! Forgotten or lost passwords are a frequent problem.

5.14 Save & Exit Setup

Settings are saved and the board is restarted.

5.15 Exit Without Saving

This option leaves the setup without saving any changes.

6 BIOS update

If a BIOS update becomes necessary, the program “AWDFLASH.EXE” from Phoenix Technologies is used for this. It is important, that the program is started from a DOS environment without a virtual memory manager such as for example “EMM386.EXE”. In case such a memory manager is loaded, the program will stop with an error message.
The system must not be interrupted during the flash process, otherwise the update is stopped and the BIOS is destroyed afterwards.
The program should be started as follows:

```
awdflash [biosfilename] /sn /cc /cp
```

/sn	Do not save the current BIOS
/cc	Clear the CMOS
/cp	Clear the PnP information

The erasure of CMOS and PnP is strongly recommended. This ensures, that the new BIOS works correctly and that all chipset registers, which were saved in the setup, are reinitialized through the BIOS. DMI should only be erased (option /cd) if the BIOS supplier advises to do so.
A complete description of all valid parameters is shown with the parameter “/?”.
In order to make the updating process run automatically, the parameter “/py” must be added. This parameter bypasses all security checks during programming.

CAUTION

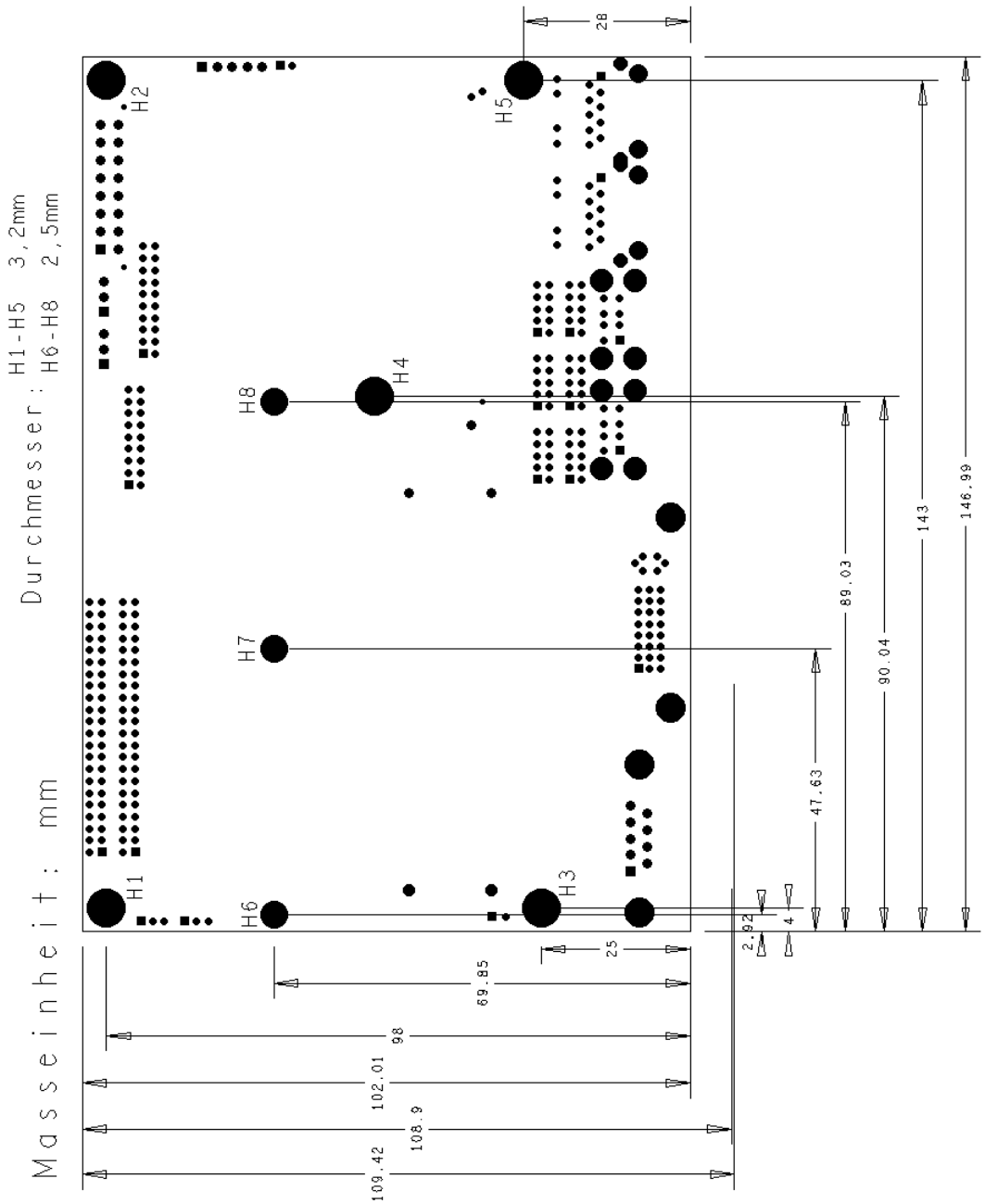
Updating the BIOS in an improper way can render the board unusable. Therefore, you should only update the BIOS if you really need the changes/corrections which come with the new BIOS version.

CAUTION

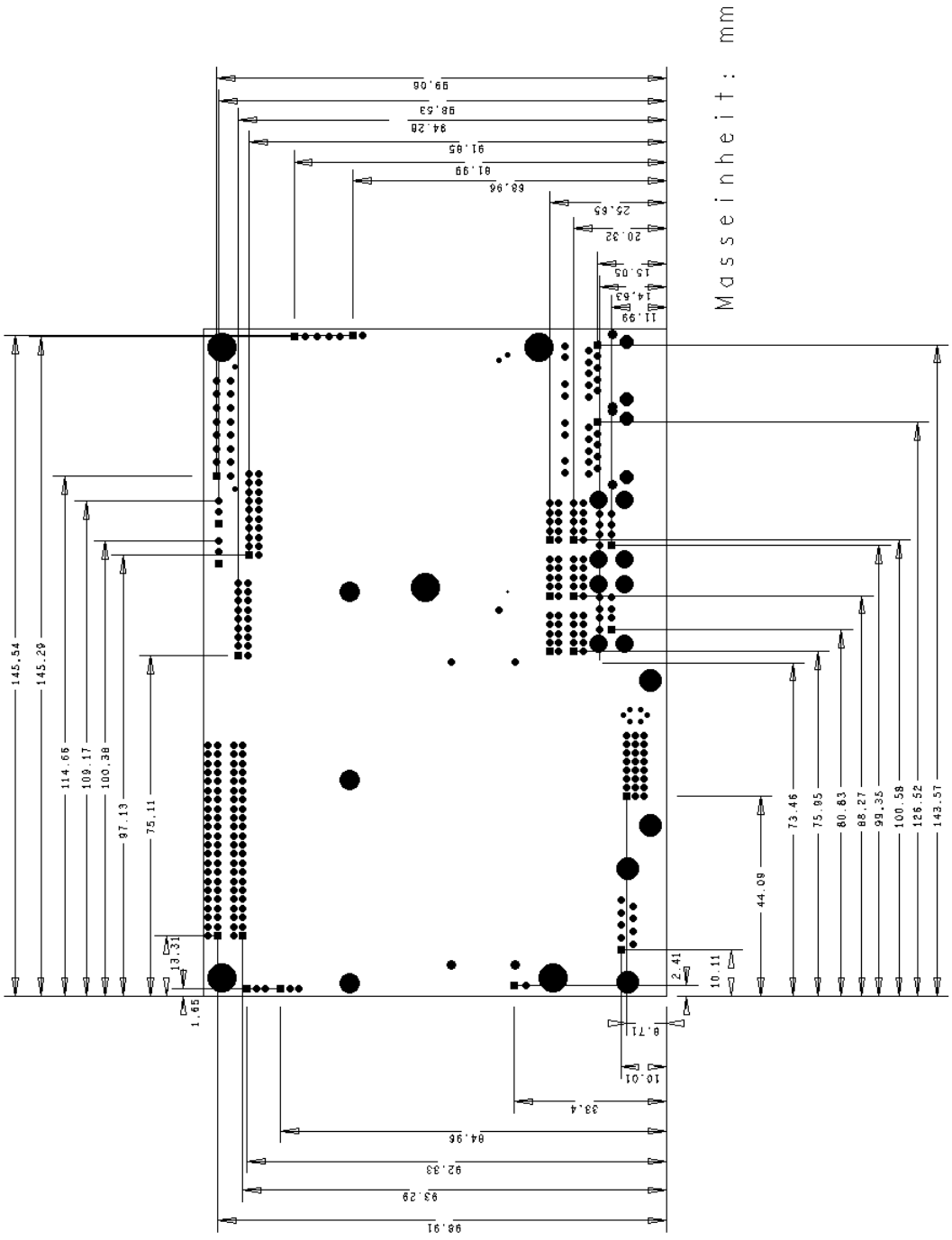
Before you proceed to update the BIOS you need to make absolutely sure that you have the right BIOS file which was issued for the exact board and exact board revision that you wish to update. If you try to update the BIOS using the wrong file the board will not start up again.

7 Mechanical Drawings

7.1 PCB: Mounting Holes



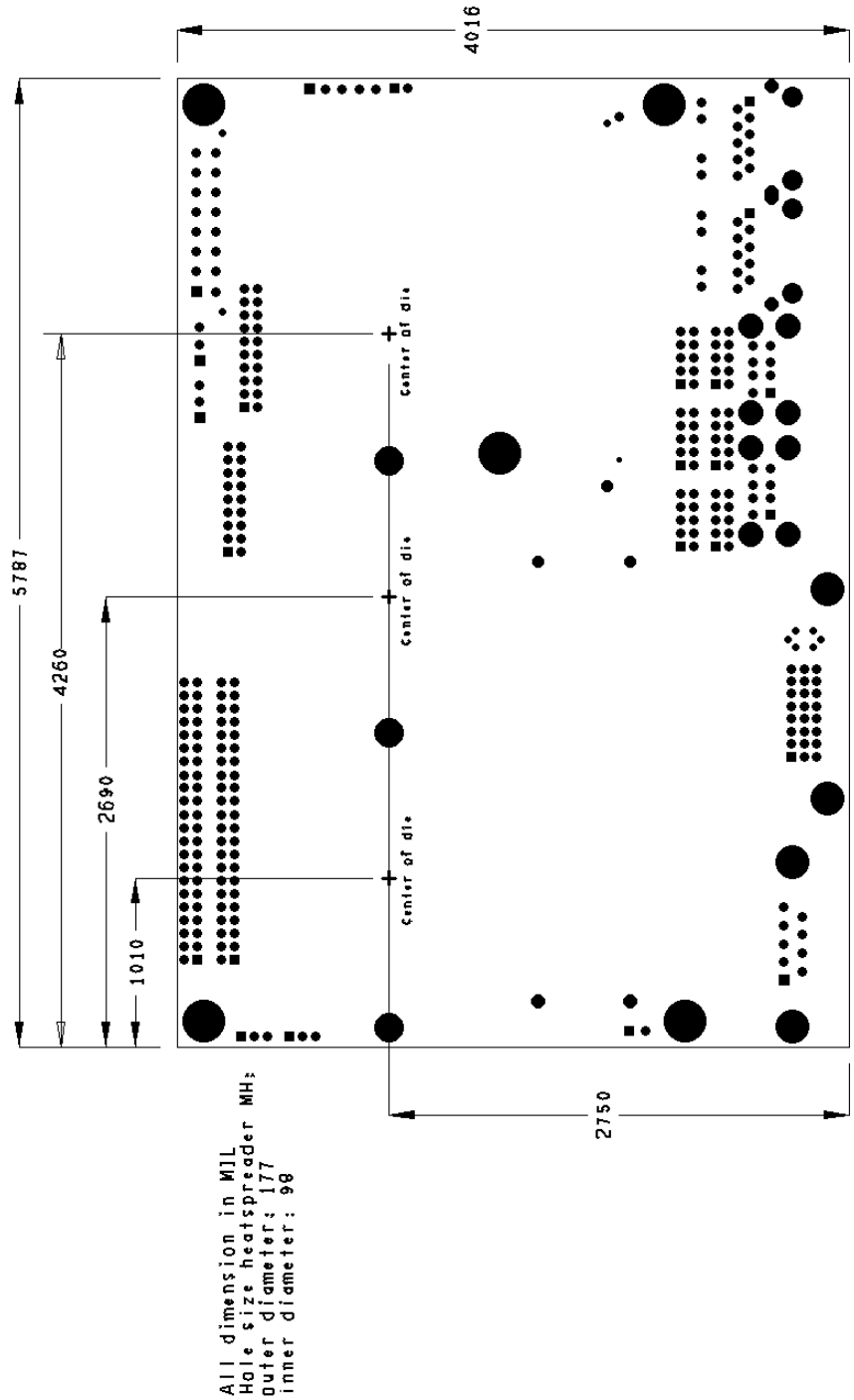
7.2 PCB: Pin 1 Dimensions



7.3 PCB: Heat Spreader

NOTE

All dimensions are in mil (1 mil = 0,0254 mm)



8 Technical Data

8.1 Electrical Data

Power Supply:

Board:	5 Volt +/- 5% (5 Volt Suspend / 12 Volt Fan)
RTC:	>= 3 Volt

Electric Power Consumption:

RTC:	<= 10µA

8.2 Environmental Conditions

Temperature Range:

Operating:	0°C to +60°C (extended temperature on request)
Storage:	-25°C up to +85°C
Shipping:	-25°C up to +85°C, for packaged boards

Temperature Changes:

Operating:	0.5°C per minute, 7.5°C per 30 minutes
Storage:	1.0°C per minute
Shipping:	1.0°C per minute, for packaged boards

Relative Humidity:

Operating:	5% up to 85% (non condensing)
Storage:	5% up to 95% (non condensing)
Shipping:	5% up to 100% (non condensing), for packaged boards

Shock:

Operating:	150m/s^2, 6ms
Storage:	400m/s^2, 6ms
Shipping:	400m/s^2, 6ms, for packaged boards

Vibration:

Operating:	10 up to 58Hz, 0.075mm amplitude
	58 up to 500Hz, 10m/s^2
Storage:	5 up to 9Hz, 3.5mm amplitude
	9 up to 500Hz, 10m/s^2
Shipping:	5 up to 9Hz, 3.5mm amplitude
	9 up to 500Hz, 10m/s^2, for packaged boards

CAUTION

Shock and vibration figures pertain to the motherboard alone and do not include additional components such as heat sinks, memory modules, cables etc.

8.3 Thermal Specifications

The board is specified to operate in an environmental temperature range from 0°C to +60°C (extended temperature on request). Maximum die temperature is 100°C. To keep the processor under this threshold an appropriate cooling solution needs to be applied. This solution has to take typical and maximum power consumption into account. The maximum power consumption may be twice as high and should be used as a basis for the cooling concept. Additional controllers may also affect the cooling concept. The power consumption of such components may be comparable to the consumption of the processor.
The board design includes thermal solution mounting points that will provide the best possible thermal interface between die and solution. Since we take thermal solutions seriously we have several advanced, aggressive cooling solutions in our product portfolio. Please contact your sales representative to order or discuss your thermal solution needs.

CAUTION

The end customer has the responsibility to ensure that the die temperature of the processor does not exceed 100°C. Permanent overheating may destroy the board!
In case the temperature exceeds 100°C the environmental temperature must be reduced. Under certain circumstances sufficient air circulation must be provided.

9 Support and Service

Beckhoff and their partners around the world offer comprehensive support and service, making available fast and competent assistance with all questions related to Beckhoff products and system solutions.

9.1 Beckhoff's Branch Offices and Representatives

Please contact your Beckhoff branch office or representative for local support and service on Beckhoff products.
The addresses of Beckhoff's branch offices and representatives around the world can be found on her internet pages: http://www.beckhoff.com
You will also find further documentation for Beckhoff components there.

9.2 Beckhoff Headquarters

Beckhoff Automation GmbH
Eiserstr. 5
33415 Verl
Germany

phone: +49(0)5246/963-0
fax: +49(0)5246/963-198
e-mail: info@beckhoff.com
web: www.beckhoff.com

9.2.1 Beckhoff Support

Support offers you comprehensive technical assistance, helping you not only with the application of individual Beckhoff products, but also with other, wide-ranging services:

- support
- design, programming and commissioning of complex automation systems
- and extensive training programs for Beckhoff system components

hotline: +49(0)5246/963-157
fax: +49(0)5246/963-9157
e-mail: support@beckhoff.com

9.2.2 Beckhoff Service

The Beckhoff Service Center supports you in all matters of after-sales service:

- on-site service
- repair service
- spare parts service
- hotline service

hotline: +49(0)5246/963-460
fax: +49(0)5246/963-479
e-mail: service@beckhoff.com

I Annex: Post-Codes

Code	Description
01h	The Xgroup-program code is written in the random access memory from address 1000:0 onwards.
03h	Initialise Variable/Routine "Superio_Early_Init".
05h	1. Cancel display 2. Cancel CMOS error flag
07h	1. Cancel 8042 (keyboard controller) Interface Register 2. Initialising and self testing of 8042 (keyboard controller)
08h	1. Test of special keyboard controllers (Winbond 977 super I/O Chip-series). 2. Enabling of the keyboard-interface register
0Ah	1. Disabling of the PS/2 mouse interface (optional). 2. Auto-detection of the connectors for Keyboard and mouse, optional: swap of PS/2 mouse ports and PS/2 interfaces.
0Eh	Test of the F000h-memory segment (Read/Write ability). In case of an error a signal will come out of the loud speakers.
10h	Auto-detection of the flash-rom-type and loading of the suitable Read/Write program into the run time memory segment F000 (it is required for ESCD-data & the DMI-pool-support).
12h	Interface-test of the CMOS RAM-logic (walking 1's"-algorithm). Setting of the power status of the real-time-clock (RTC), afterwards test of register overflow.
14h	Initialising of the chip-set with default values. They can be modified through a software (MODBIN) by the OEM-customer.
16h	Initialise Variable/Routine "Early_Init_Onboard_Generator".
18h	CPU auto-detection (manufacturer, SMI type (Cyrix or Intel), CPU-class (586 or 686).
1Bh	Initialising if the interrupt pointer table. If nothing else is pretended, the hardware interrupts will point on "SPURIOUS_INT_HDLR and the software interrupts will point on SPURIOUS_soft_HDLR.
1Dh	Initialise Variable/Routine EARLY_PM_INIT.
1Fh	Load the keyboard table (Notebooks)
21h	Initialising of the hardware power management (HPM) (Notebooks)
23h	1. Test the validity of the RTC-values (Example: "5Ah" is an invalid value for an RTC-minute). 2. Load the CMOS-values into the BIOS Stack. Default-values are loaded if CMOS-checksum errors occur. 3. Preparing of the BIOS 'resource map' for the PCI & plug and play configuration. If ESCD is valid, take into consideration the ESCD's legacy information. 4. Initialise the onboard clock generator. Clock circuit at non-used PCI- and DIMM slots. 5. First initialising of PCI-devices: assign PCI-bus numbers - alot memory- & I/O resources - search for functional VGA-controllers and VGA-BIOS and copy the latter into memory segment C000:0 (Video ROM Shadow).
27h	Initialise cache memory for INT 09
29h	1. Program the CPU (internal MTRR at P6 and PII) for the first memory address range (0-640K). 2. Initialising of the APIC at CPUs of the Pentium-class. 3. Program the chip-set according to the settings of the CMOS-set-up (Example: Onboard IDE-controller). 4. Measuring of the CPU clock speed. 5. Initialise the video BIOS.
2Dh	1. Initialise the "Multi-Language"-function of the BIOS 2. Soft copy, e.g. Award-Logo, CPU-type and CPU clock speed…
33h	Keyboard-reset (except super I/O chips of the Winbond 977 series)
3Ch	Test the 8254 (timer device)
3Eh	Test the interrupt Mask bits of IRQ-channel 1 of the interrupt controller 8259.
40h	Test the interrupt Mask bits of IRQ-channel 2 of the interrupt controller 8259
43h	Testing the function of the interrupt controller (8259).
47h	Initialise EISA slot (if existent).

Code	Description
49h	1. Determination of the entire memory size by revising the last 32-Bit double word of each 64k memory segment. 2. Program “write allocation” at AMD K5-CPUs.
4Eh	1. Program MTRR at M1 CPUs 2. Initialise level 2-cache at CPUs of the class P6 and set the “cacheable range” of the random access memory. 3. Initialise APIC at CPUs of the class P6. 4. Only for multiprocessor systems (MP platform): Setting of the “cacheable range” on the respective smallest value (for the case of non-identical values).
50h	Initialise USB interface
52h	Testing of the entire random access memory and deleting of the extended memory (put on “0”)
55h	Only for multi processor systems (MP platform): Indicate the number of CPUs.
57h	1. Indicate the plug and play logo 2. First ISA plug and play initialising – CSN-assignment for each identified ISA plug and play device.
59h	Initialise TrendMicro anti virus program code.
5Bh	(Optional:) Indication of the possibility to start AWDFLASH.EXE (Flash ROM programming) from the hard disk.
5Dh	1. Initialise Variable/Routine Init_Onboard_Super_IO. 2. Initialise Variable/Routine Init_Onbaord_AUDIO.
60h	Release for starting the CMOS set-up (this means that before this step of POST, users are not able to access the BIOS set-up).
65h	Initialising of the PS/2 mouse.
67h	Information concerning the size of random access memory for function call (INT 15h with AX-Reg. = E820h).
69h	Enable level 2 cache
6Bh	Programming of the chip set register according to the BIOS set-up and auto-detection table.
6Dh	1. Assignment of resources for all ISA plug and play devices. 2. Assignment of the port address for onboard COM-ports (only if an automatic junction has been defined in the setup).
6Fh	1. Initialising of the floppy controller 2. Programming of all relevant registers and variables (floppy and floppy controller).
73h	Optional feature: Call of AWDFLASH.EXE if: - the AWDFLASH program was found on a disk in the floppy drive. - the shortcut ALT+F2 was pressed.
75h	Detection and installation of the IDE drives: HDD, LS120, ZIP, CDROM…
77h	Detection of parallel and serial ports.
7Ah	Co-processor is detected and enabled.
7Fh	1. Switch over to the text mode, the logo output is supported. - Indication of possibly emerged errors. Waiting for keyboard entry. - No errors emerged, respective F1 key was pressed (continue): Deleting of the EPA- or own logo.
82h	1. Call the pointer to the “chip set power management”. 2. Load the text font of the EPA-logo (not if a complete picture is displayed) 3. If a password is set, it is asked here.
83h	Saving of the data in the stack, back to CMOS.
84h	Initialising of ISA plug and play boot drives (also Boot-ROMs)
85h	1. Final initialising of the USB-host. 2. At network PCs (Boot-ROM): Construction of a SYSID structure table 3. Backspace the scope presentation into the text mode 4. Initialise the ACPI table (top of memory). 5. Initialise and link ROMs on ISA cards 6. Assignment of PCI-IRQs 7. Initialising of the advanced power management (APM) 8. Set back the IRQ-register.

Code	Description
93h	Reading in of the hard disk boot sector for the inspection through the internal anti virus program (trend anti virus code)
94h	1. Enabling of level 2 cache 2. Setting of the clock speed during the boot process 3. Final initialising of the chip set. 4. Final initialising of the power management. 5. Erase the onscreen and display the overview table (rectangular box). 6. Program “write allocation” at K6 CPUs (AMD) 7. Program “write combining” at P6 CPUs (INTEL)
95h	1. Program the changeover of summer-and winter-time 2. Update settings of keyboard-LED and keyboard repeat rates
96h	1. Multi processor system: generate MP-table 2. Generate and update ESCD-table 3. Correct century settings in the CMOS (20xx or 19xx) 4. Synchronise the DOS-system timer with CMOS-time 5. Generate an MSIRQ-Routing table..
C0h	Chip set initialising: - Cut off shadow RAM - Cut off L2 cache (apron 7 or older) - Initialise chip set register
C1h	Memory detection: Auto detection of DRAM size, type and error correction (ECC or none) Auto detection of L2 cache size (apron 7 or older)
C3h	Unpacking of the packed BIOS program codes into the random access memory.
C5h	Copying of the BIOS program code into the shadow RAM (segments E000 & F000) via chipset hook.
CFh	Testing of the CMOS read/write functionality
FFh	Boot trial over boot-loader-routine (software-interrupt INT 19h)

II Annex: Resources

IO Range

The used resources depend on setup settings.
The given values are ranges, which are fixed by AT compatibility. Other IO ranges are used, which are dynamically adjusted by Plug & Play BIOS while booting.

Address	Function
0-FF	Reserved IO area of the board
170-17F	IDE2
1F0-1F7	IDE1
278-27F	LPT2
2E8-2EF	COM4
2F8-2FF	COM2
370-377	FDC2
378-37F	LPT1
3BC-3BF	LPT3
3E8-3EF	COM3
3F0-3F7	FDC1
3F8-3FF	COM1

Memory Range

The used resources depend on setup settings.
If the entire range is clogged through option ROMs, these functions do not work anymore.

Address	Function
A0000-BFFFF	VGA RAM
C0000-CFFFF	VGA BIOS
D0000-DFFFF	AHCI BIOS / RAID / PXE (if available)
E0000-EFFFF	System BIOS while booting
F0000-FFFFF	System BIOS

Interrupt

The used resources depend on setup settings.
The listed interrupts and their use are given through AT compatibility.
If interrupts must exclusively be available on the ISA side, they have to be reserved through the BIOS setup.
The exclusivity is not given and not possible on the PCI side.

Address	Function
IRQ0	Timer
IRQ1	PS/2 Keyboard
IRQ2 (9)	(COM3)
IRQ3	COM1
IRQ4	COM2
IRQ5	(COM4)
IRQ6	FDC
IRQ7	LPT1
IRQ8	RTC
IRQ9	
IRQ10	
IRQ11	
IRQ12	PS/2 Mouse

Address	Function
IRQ13	FPU
IRQ14	IDE Primary
IRQ15	(IDE Secondary)

PCI Devices

All listed PCI devices exist on the board. Some PCI devices or functions of devices may be disabled in the BIOS setup. Once a device is disabled other devices may get PCI bus numbers different from the ones listed in the table.

AD	INTA	REQ	PCI	Dev.	Fct.	Controller / Slot
	-	-	0	0	0	Host Bridge ID3580
	-	-	0	0	1	ID3584
	-	-	0	0	3	ID3585
	A	-	0	2	0	VGA Graphics ID3582
	-	-	0	2	1	Graphics Controller ID3582
	A	-	0	29	0	USB UHCI Controller #1 ID24C2
	D	-	0	29	1	USB UHCI Controller #2 ID24C4
	C	-	0	29	2	USB UHCI Controller #3 ID24C7
	H	-	0	29	7	USB 2.0 EHCI Controller ID24CD
	-	-	0	30	0	Hub Interface to PCI Bridge ID244E
	-	-	0	31	0	PCI to LPC Bridge ID24C0
	C	-	0	31	1	IDE Controller ID24CB
	B	-	0	31	3	SMBus Controller ID24C3
	B	-	0	31	5	AC ’97 Audio Controller ID24C5
	B	-	0	31	6	AC ’97 Modem Controller ID24C6
21	A		1 or 2	5		External Slot (Mini PCI)
24	E	-	1 or 2	8	0	LAN internal ICH4 ID103A

SMB Devices

The following table contains all reserved SM-Bus device addresses in 8-bit notation. Note that external devices must not use any of these addresses even if the component mentioned in the table is not present on the motherboard.

Address	Function
10-11	Standard slave address
40-41	GPIO
60-61	BIOS internal
70-73	POST code output
88-89	BIOS-defined slave address
A0-A1	DIMM 1
A2-A3	DIMM 2
A4-AF	BIOS internal
B0-BF	BIOS internal
D2-D3	Clock